

# RTV Silicone Rubbers

## for Electrical & Electronic Applications



Safe and eco-friendly

# RTV Silicone Rubber

## Making electrical & electronic equipment more reliable.

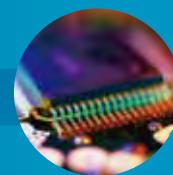
Electronic devices and electrical modules are constantly evolving in performance and functionality while becoming smaller and more lightweight. At the same time, “green design” has become the norm. These factors have created a demand for materials that offer higher quality, higher functionality and more eco-friendly properties.

- ▶ Improving the reliability of today’s safer, greener car electronics
- ▶ Boosting the reliability of next-generation energy systems including solar cells, wind power, and fuel cells
- ▶ Boosting the reliability of PCUs (Power Control Units), which are essential to making consumer electronics, hybrid vehicles, electric vehicles and railways more energy efficient; and that of power modules including power conditioners, which are critical components of alternative energy systems including solar and wind power
- ▶ Telecommunications and optoelectronics, including eco-friendly LEDs
- ▶ Thermal interface technologies that help protect electronic devices from heat

These and many other leading-edge technologies would not exist without RTV silicone rubber. At Shin-Etsu, we’re developing RTV rubber products that contribute to more comfortable living and to advancements in eco-friendly electronics technology.

## CONTENTS

<b>Features of silicone</b>	● P3
<b>Main property requirements for RTV silicone rubbers for electrical &amp; electronic applications</b>	● P4-6
<b>Basic information about RTV silicone rubber</b>	● P7-9
• Types of RTV silicone rubber • Viscosity and workability • Curing reactions • Low-molecular-weight siloxane and electrical contact failures	
<b>Main applications for RTV silicone rubber</b>	● P10-11
• LED devices • IGBT Modules • ECUs • Circuit board assemblies	
<b>Product lists</b>	● P12-25
• Adhesives and sealants	● P12-15
• Potting agents (rubber)	● P16
• Potting agents (gel)	● P17
• Coating agents	● P18-19
• Thermal interface materials	● P20-21
• LED encapsulants	● P22-23
• Device die-bonding adhesives, damming materials & reflector materials	● P24
• UV curable products	● P25
<b>Packaging options / Product index</b>	● P26-27
<b>Packaging</b>	● P28
<b>UL certified products</b>	● P29
<b>Instructions for use</b>	● P30
<b>Handling precautions</b>	● P31



# Features of silicone

## Silicones have an amazing array of properties.

Silicones consist of a main chain of inorganic siloxane linkages (Si-O-Si) plus side chains which contain organic groups. **Silicones are hybrid polymers that contain both inorganic and organic components.**



## The main chain of a silicone consists of siloxane linkages which are stable and have a high bonding energy.

Compared to organic polymers, which have a carbon skeleton (C-C/bonding energy: 85 kcal/mol), silicones have superior **heat resistance and weatherability** (UV light, ozone). This is due to the greater stability of siloxane bonds, which have a bonding energy of 106 kcal/mol.

## With their long bond length and high bond angle, siloxane bonds have weak intermolecular forces and move freely.

Siloxane bonds have a bond length of 1.64 Å and bond angle of 134°. Compared to carbon bonds (bond distance: 1.54 Å, bond angle: 110°), they have a long bond distance and high bond angle, and a low rotational energy barrier. As a result, siloxane bonds move more freely and intermolecular forces are weak. These characteristics manifest themselves in features of the silicone material, including **softness, gas permeability, cold resistance, and little change in viscosity due to temperature changes.**

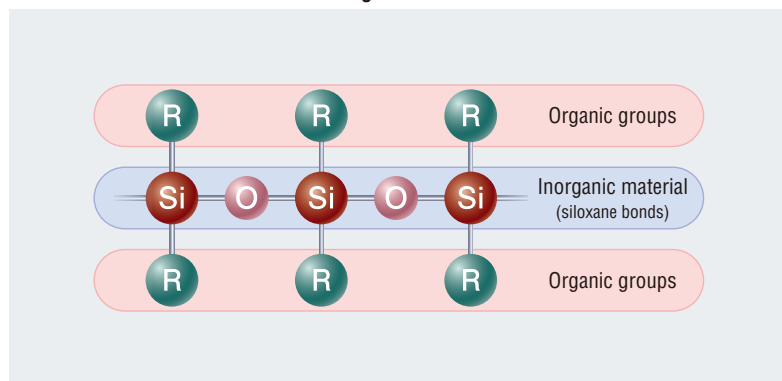
## The molecules of silicone polymers are covered by hydrophobic methyl groups, and surface energy is low.

The backbone of a silicone polymer molecule is a twisted helical structure. The molecules are almost completely covered by hydrophobic methyl groups, and surface energy is low. This gives rise to unique properties including **water repellency and easy release.**

Moreover, silicones are low-polarity polymers, so they absorb **little moisture.**

## Silicones: compounds which feature a main chain of siloxane bonds

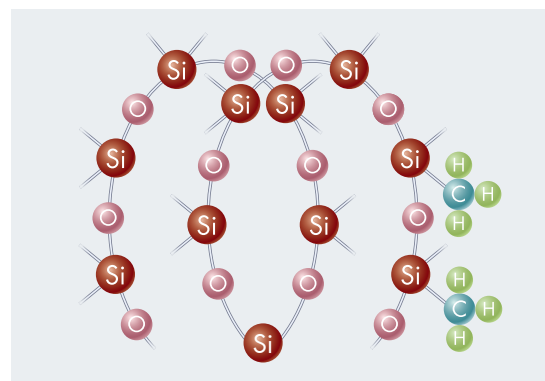
### Features attributable to siloxane linkages



- Heat resistance
- Weatherability
- Flame resistance
- Radiation resistance
- Chemical stability
- Electrical properties

Si-O bonds: 106 kcal/mol  
C-C bonds: 85 kcal/mol  
C-O bonds: 76 kcal/mol

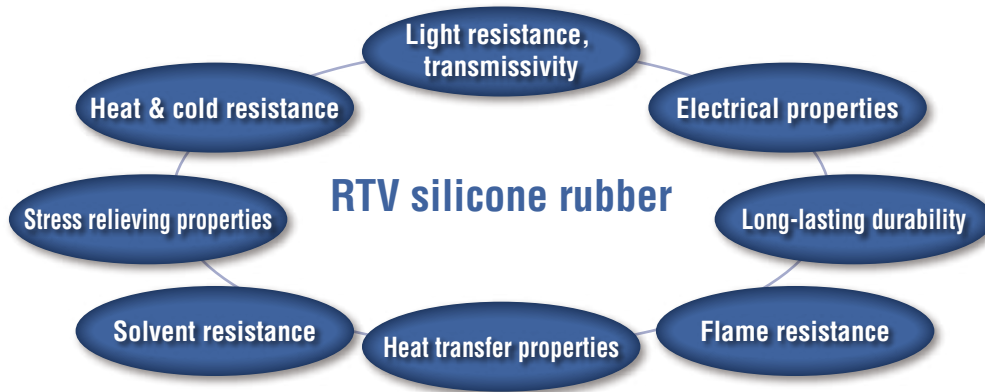
### Features attributable to molecular structure



- Water repellency
- Cold resistance
- Release properties
- Compression characteristics

Helical (spiral) structure  
Intermolecular forces are weak

# Main property requirements for RTV silicone rubbers for electrical & electronic



## Feature 1 Light resistance & transmissivity

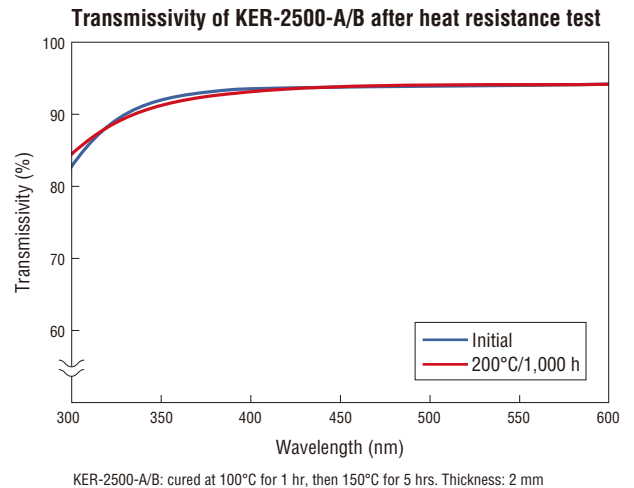
Silicone materials can be used for fastening and encapsulation of LEDs and other light receiving/emitting devices without harming the optical characteristics of the optical device.

## Feature 2 Heat & cold resistance

Silicone can be used in temperatures from  $-50^{\circ}\text{C}$  to  $+250^{\circ}\text{C}$ . Even in continuous use, RTV silicone rubber offers stable performance in a wide temperature range ( $-40^{\circ}\text{C}$  to  $+180^{\circ}\text{C}$ ) and does not lose its rubber elasticity.

## Feature 3 Electrical properties

Silicone exhibits consistent electrical properties even when subjected to environmental changes (temperature, humidity, etc.). This makes silicone a good insulator for high voltage components of transformers and other equipment.



### 3-1. Tracking resistance of KE-3467 & KE-1867

Product name \ Voltage	300 V	800 V
KE-3467	Pass	Pass
KE-1867	Pass	Pass

How CTI value is measured

CTI is measured by dripping 50 drops of an electrolyte solution onto an insulating material at a rate of one drop every 30 seconds\*, and the CTI value is the maximum voltage at which no tracking failure occurs. The larger the CTI value, the more resistant the material is to tracking.  
\* ASTM D 3638-85 (IEC 112)  
Conditions stipulated in "Standard Test Method for Comparative Tracking Index of Electrical Insulating Materials".

(Not specified values)

### 3-2. Volume resistivity & dielectric breakdown strength of KE-3490 at $85^{\circ}\text{C}/85\% \text{RH}$

	Initial	240 h	480 h	960 h	1,440 h
Volume resistivity $\text{T}\Omega\cdot\text{m}$	3.6	21	32	40	53
Relative permittivity 50 Hz	3.1	3.2	3.1	3.0	3.1
Dissipation factor 50 Hz	$5 \times 10^{-3}$	$4 \times 10^{-3}$	$3 \times 10^{-3}$	$3 \times 10^{-3}$	$3 \times 10^{-3}$
Dielectric breakdown strength kV/mm	32	31	31	30	29

Cure conditions:  $23^{\circ}\text{C}/50\% \text{RH} \times 7$  days. Durability conditions:  $85^{\circ}\text{C}/85\% \text{RH} \times$  prescribed time

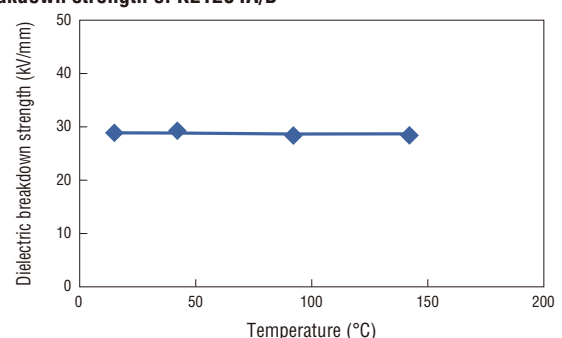
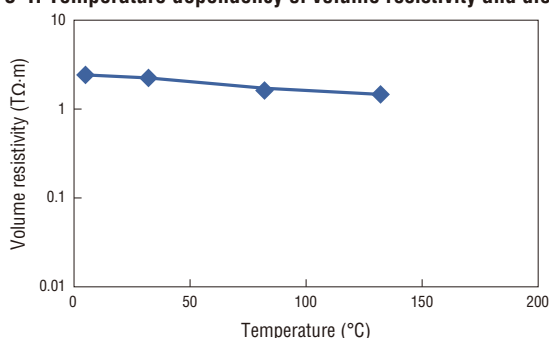
(Not specified values)

### 3-3. Volume resistivity & dielectric breakdown strength of KE-3490 after $150^{\circ}\text{C}$ durability test

	Initial	$150^{\circ}\text{C} \times 250$ h	$150^{\circ}\text{C} \times 500$ h	$150^{\circ}\text{C} \times 1,000$ h
Volume resistivity $\text{T}\Omega\cdot\text{m}$	3.6	$6.0 \times 10^1$	$2.9 \times 10^2$	$7.0 \times 10^2$
Dielectric breakdown strength kV/mm	32	29	30	29

(Not specified values)

### 3-4. Temperature dependency of volume resistivity and dielectric breakdown strength of KE1204A/B





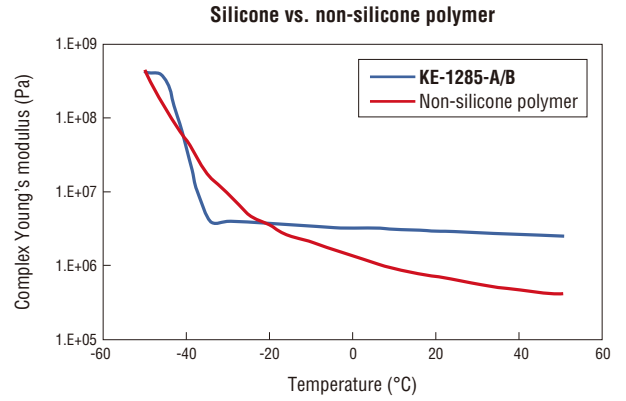
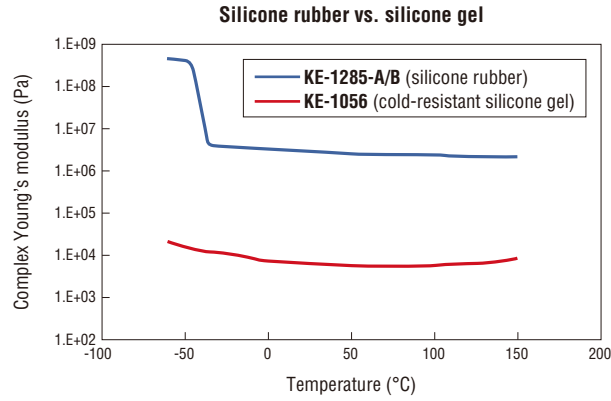
Feature

## 4

### Stress relieving properties

Silicone is used for potting and encapsulation of bonding wires and other components of power semiconductor modules. Silicone protects electronic parts from stress and is effective across a wide temperature range.

#### 4-1. Temperature dependency of complex Young's modulus of RTV silicone



Feature

## 5

### Long-lasting durability

#### 5-1. Physical properties of KE-1285 after 150°C durability test

	Initial	150 h	300 h	500 h	650 h	800 h	1,000 h
Hardness Durometer A	56	58	61	63	63	63	64
Elongation at break %	140	120	110	120	110	100	90
Tensile strength MPa	2.8	2.9	3.0	3.3	3.3	3.3	2.8
Density g/cm <sup>3</sup>	1.72	1.72	1.73	1.72	1.73	1.73	1.73
Tensile lap-shear strength (Al/Al) MPa	1.5	1.7	1.5	1.7	1.9	1.6	1.8
Volume resistivity TΩ·cm	6.5	8.6 × 10	9.6 × 10	1.0 × 10 <sup>2</sup>	1.5 × 10 <sup>2</sup>	8.0 × 10	1.8 × 10 <sup>2</sup>

(Not specified values)

#### 5-2. Physical properties of KE-1285 after 85°C/85% RH durability test

	Initial	150 h	300 h	500 h	650 h	800 h	1,000 h
Hardness Durometer A	56	56	56	59	59	60	58
Elongation at break %	140	120	130	140	120	130	110
Tensile strength MPa	2.8	2.6	2.6	2.9	2.7	2.8	2.4
Density g/cm <sup>3</sup>	1.72	1.72	1.72	1.72	1.72	1.72	1.72
Tensile lap-shear strength (Al/Al) MPa	1.5	1.5	1.4	1.7	1.5	1.4	1.4
Volume resistivity TΩ·cm	6.5	2.0 × 10	2.7 × 10	2.6 × 10	2.9 × 10	3.8 × 10	3.0 × 10

(Not specified values)

Feature

## 6

### Solvent resistance

#### Change in volume of rubbers caused by various liquids (after 168 hr immersion)

(unit: %)

Liquid	Temperature °C	Nitrile			Chloroprene	Natural rubber	Styrene Butadiene	Butyl	Silicone*	Hypalon
		28%	33%	38%						
Gasoline	50	15	10	6	55	250	140	240	260	85
ASTM #1 oil	50	-1	-1.5	-2	5	60	12	20	4	4
ASTM #3 oil	50	10	3	0.5	65	200	130	120	40	65
Diesel oil	50	20	12	5	70	250	150	250	150	120
Formaldehyde	50	10	10	10	25	6	7	0.5	1	1.2
Ethanol	50	20	20	18	7	3	-5	2	15	5
Glycol	50	0.5	0.5	0.5	2	0.5	0.5	-0.2	1	0.5
Ethyl ether	50	50	30	20	95	170	135	90	270	85
Methyl ethyl ketone	50	250	250	250	150	85	80	15	150	150
Trichloroethylene	50	290	230	230	380	420	400	300	300	600
Carbon tetrachloride	50	110	75	55	330	420	400	275	300	350
Benzene	50	250	200	160	300	350	350	150	240	430
Aniline	50	360	380	420	125	15	30	10	7	70
Phenol	50	450	470	510	85	35	60	3	10	80
Cyclohexanol	50	50	40	25	40	55	35	7	25	20
Distilled water	100	10	11	12	12	10	2.5	5	2	4

\* The values above are measured values for common dimethyl silicone rubber. Values will differ depending on the product.

Feature

7

### Flame resistance

There are many UL certified products on the market.

A product's UL certification can be checked by referring to the directory at the following page: <http://iq.ul.com/iq/newiq/>

Check the following UL file numbers for details.

UL file numbers: **E48923, E179895, E174951, E255646, E192980**

#### UL94 flammability ratings criteria

Rating	Criteria
<b>94V-0*</b>	A set of 5 specimens is tested; the flaming combustion time of each specimen must not exceed 10 seconds, and total time of the set must not exceed 50 seconds.
<b>94V-1*</b>	A set of 5 specimens is tested; the flaming combustion time of each specimen must not exceed 30 seconds, and total time of the set must not exceed 250 seconds.
<b>94HB</b>	In this horizontal burning test, combustion must cease before the 100 mm reference mark.

\* A rectangular test strip (width: 13.0 mm, length: 125 mm, thickness: as thin as is practical) is suspended vertically. A 20 mm flame is applied to the bottom for 10 seconds. The flame is then removed and the flaming combustion time is measured. When combustion ceases, the flame is again applied in the same manner and combustion time is measured again.



Flammability test Left: Silicone rubber Right: Organic rubber

Feature

8

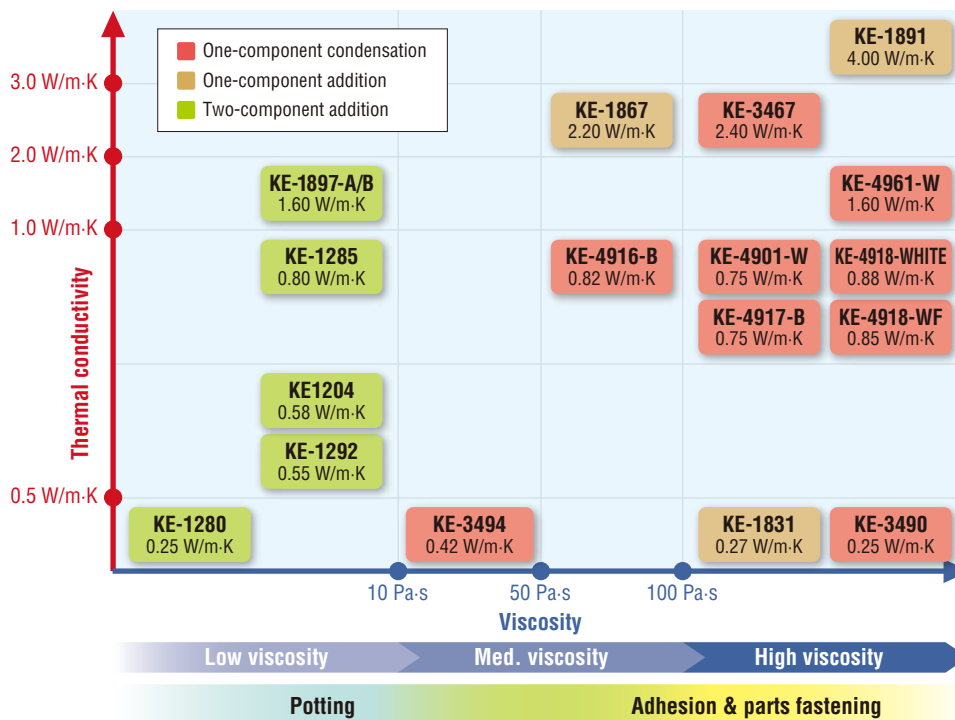
### Heat transfer properties

Silicone can help transfer heat generated by electronic devices to heat sinks and housings.

Some Shin-Etsu products that have both flame resistance and heat transfer properties are presented below.

Be sure to choose a product suitable for the intended use.

#### Products with heat transfer properties that are UL94 V-0 rated



#### ● Heat resistance evaluation & test method

Thermal conductivity (  $\lambda$  ) and thermal resistance (R) are two values which describe the thermal properties of thermal interface materials. The higher its thermal conductivity and lower its thermal resistance, the more effective a material will be as a thermal interface. Heat dissipation from a heat-generating component is influenced not only by the thermal conductivity of the thermal interface silicone placed between the heat-generating part and the heatsink (etc.). It is also influenced to a large extent by thermal resistance, which is a function of the contact thermal resistance at the interfaces between the heat generator, silicone and heat sink and the thickness of the silicone itself.

At a given temperature, thermal conductivity is a value intrinsic to a particular substance. According to Fourier's Law, in a steady state, the proportionality constant is the thermal conductivity.

Thermal conductivity  $\lambda$

$$Q = \lambda \frac{(T_1 - T_2)A}{L} \quad \text{Therefore} \quad \lambda = \frac{Q}{A} \times \frac{L}{(T_1 - T_2)}$$

Q: heat flow rate A: cross-sectional surface area L: distance of heat transfer  
T1: temperature at high side T2: temperature at low side

Thermal resistance is the sum of contact resistance plus the resistance as heat flows (Q) from T1 to T2.

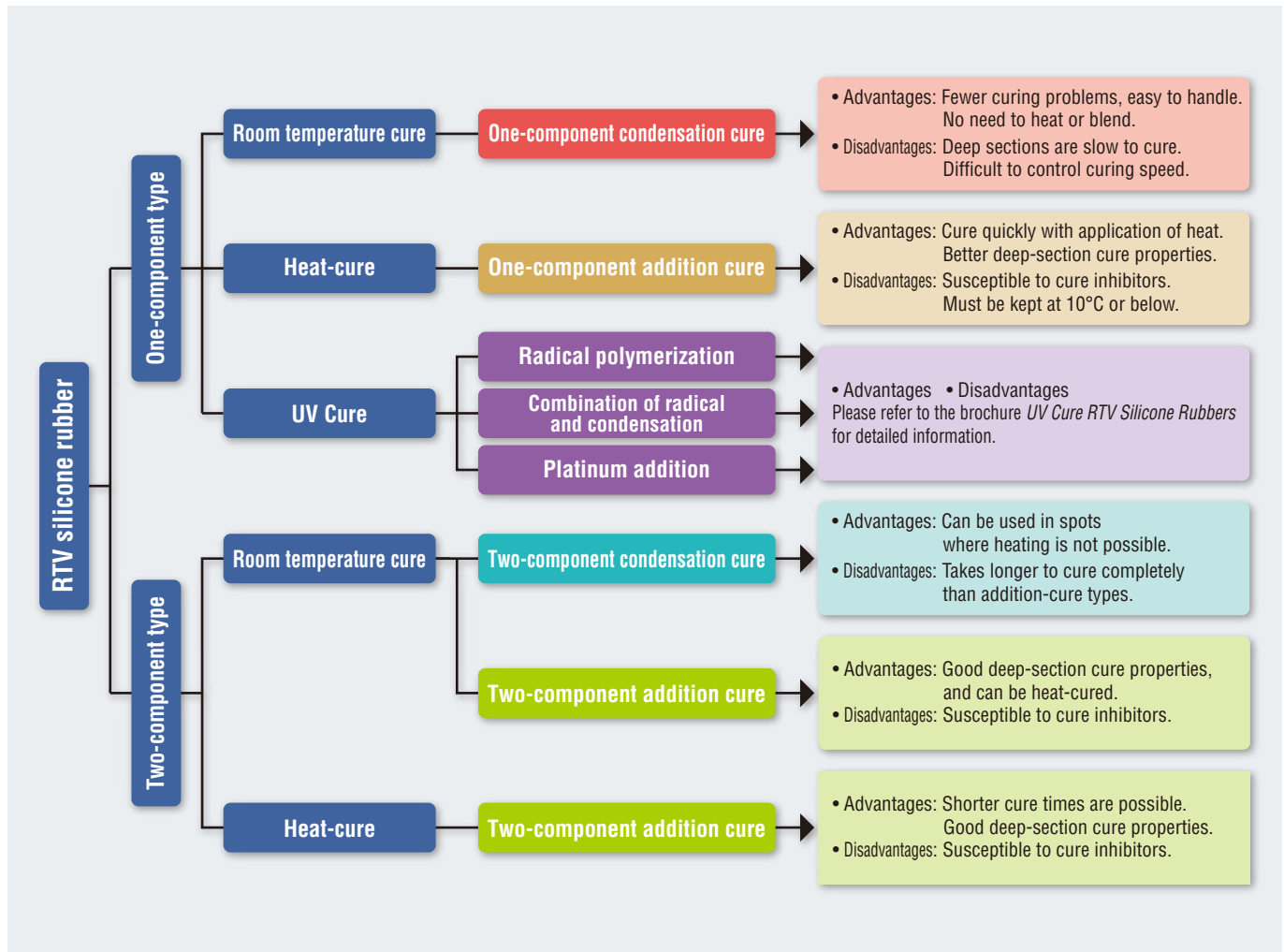
Thermal resistance R

$$R_o = \frac{T_1 - T_2}{Q} = \frac{L}{\lambda A} \quad \text{In reality} \quad R = R_o + R_s$$

Ro: material's intrinsic thermal resistance Rs: contact thermal resistance

# Basic information about RTV silicone rubber

## Types of RTV silicone rubber



## Viscosity and workability

### ● Viscosity before curing

Generally speaking, RTV silicone rubber products start as a liquid and cure to become an elastic body. The viscosity values listed in this catalog should provide a guideline as to workability. Flowable, low viscosity products are suitable for potting and coating. Medium viscosity products and non-flowable high viscosity products (paste consistency) are suitable for sealing and adhesion or fastening of parts.



## Curing reactions

Some RTV silicone rubbers cure at room temperature, while others cure with the application of heat. And in each category, products are available in one-component and two-component formats. Furthermore, the curing reaction may be a condensation reaction or an addition reaction. Each has its own advantages.

### ● Condensation reaction

These products release reaction byproducts (outgas) as they cure. Based on the type of reaction byproducts they release, products are categorized as alcohol-cure, acetone-cure, or oxime-cure products. One-component condensation cure products cure by reacting with moisture in the air. The cure reaction starts at the surface in contact with the air and proceeds inward.

Curing speed is dependent on temperature and humidity. If thickness is 1 mm, it takes about 24 hours for the material to become a fully cured elastic body.

However, it takes about three days to achieve full mechanical strength,

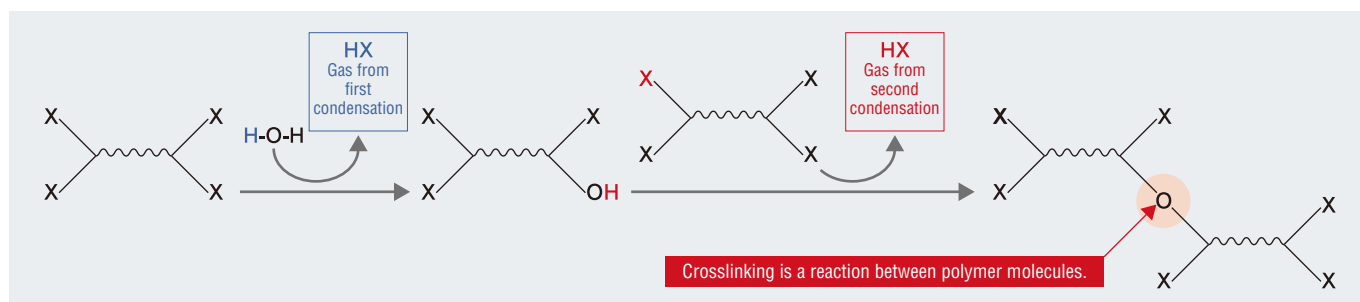
When choosing an RTV silicone rubber product, the user must consider a range of factors. These include elements of workability such as viscosity and curing conditions, performance parameters such as hardness, flame resistance and thermal conductivity; and the advantages and disadvantages of the different types of curing reactions.

and can take up to seven days to achieve the desired electrical properties and other characteristics.

These products are generally not suitable for use as an adhesive for bonding materials together with a large contact area, but may be suitable in certain cases depending on the size and moisture permeability of the substrates.

Two-component condensation cure products cure when the main component and curing agent are mixed together. The reaction occurs throughout the material, and as is the case with one-component products, reaction byproducts are released.

**Note:** Irrespective of whether it is a one- or a two-component product, condensation-cure RTV silicone rubber products require moisture to cure, and outgas during the curing process. These products are thus not suitable for applications that involve airtight enclosures.

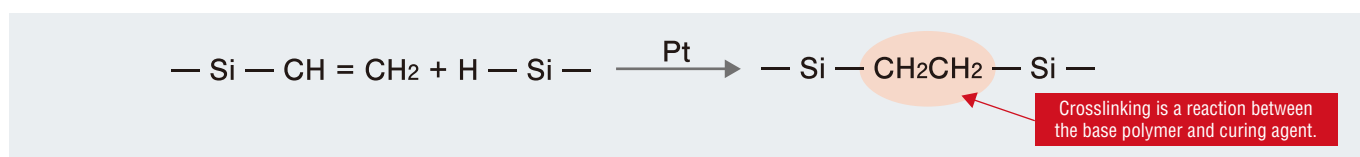


### ● Addition reaction

The base polymer (a silicone polymer which contains vinyl groups) reacts with the curing agent (a silicone polymer which contains hydrogen groups) with the aid of a platinum catalyst. It is through this hydrosilylation reaction that the material cures.

With addition-cure RTV silicone rubber products, the user has greater control over the cure time, which can be useful in terms of increasing productivity.

**Note:** However, contact with certain compounds can cause poor curing or adhesion, so these products must be used with a certain amount of care.



### Cure inhibition

When using addition-cure RTV silicone rubber products, it is important that the user have a good understanding of the problem of cure inhibition. The substances that can cause cure inhibition do so in one of the two following ways.

#### Causes of poor curing

1. The platinum catalyst forms complexes with certain other compounds, and the catalytic action is inhibited.
2. The curing agent becomes contaminated with substances it can react with, and the curing agent is consumed.

#### Cure inhibitors

- Organic compounds that contain elements which include nitrogen, phosphorus and sulfur.
- Ionic compounds of heavy metals such as tin, lead, mercury, bismuth and arsenic.
- Organic compounds that contain unsaturated groups, such as acetylene groups.

#### Substances that can react with curing agents

- Alcohol, water.
- Organic acids such as carboxylic acid.

#### Specific examples of cure inhibition

- Organic rubber: vulcanized rubber, anti-aging agent (e.g. gloves).
- Epoxy & urethane resin: amine- and isocyanate-based curing agents.
- Condensation-cure RTV silicone rubber: use of tin-based catalysts in particular.
- Soft PVC: plasticizers, stabilizers.
- Solder flux.
- Engineering plastics: flame retardants, heat resistance improvers, UV absorbers.
- Moisture that has been absorbed by materials which are in contact with the uncured material.
- Outgassing from solder resist or PCB (caused by heating when curing the silicone).



## Low-molecular-weight siloxane and electrical contact failures

### ● What is low-molecular-weight siloxane?

Low-molecular-weight (LMW) siloxane is shown in the chemical formula on the right. It is non-reactive cyclic dimethyl polysiloxane (generally D<sub>3</sub>–D<sub>10</sub>) that is volatile, meaning it will vaporize into the air during the cure process and even after curing.

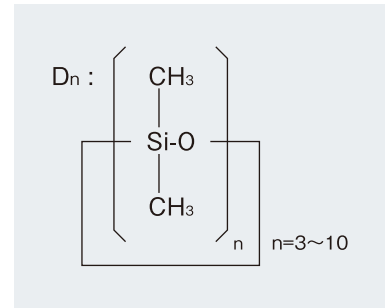
It has been reported that, in certain conditions (described below), LMW siloxane can cause electrical contact failures.

### ● Reduced LMW siloxane products (designed to reduce incidence of electrical contact failures)

These are products in which LMW siloxane has been reduced to a prescribed level. LMW siloxane is known to cause electrical contact failures in certain conditions.

For most Shin-Etsu products, this means a ΣDn (n=3–10) of 300 ppm or less, or 500 ppm or less.

The risk of electrical contact failures is also affected by the conditions described below, so these products do not represent an absolute solution. Nonetheless, reduced LMW siloxane products are still recommended for electrical and electronic applications.



### Amounts of LMW siloxane in regular products and reduced LMW siloxane products (sample data on uncured material)

Dn	KE-45 (Regular product)	KE-3490 (Reduced LMW siloxane product)
3	10 >	10 >
4	500	10 >
5	260	10 >
6	240	10 >
7	220	10 >
8	160	50
9	170	50
10	220	60
ΣDn (n=3–10)	1,770	160

KE-3490 is a reduced LMW siloxane product with ΣDn (n=3–10) controlled to 300 ppm or less.

(Not specified values)

[GC conditions] GC: gas chromatography  
 Device Capillary gas chromatograph, Shimadzu model GC-14A  
 Column DURABOND DB-1701  
 Column Temp. 50°C → 300°C (15°C/min)  
 Inj. Temp. 300°C  
 Carrier Gas He (30 cm/sec)  
 Detector: FID  
 Injection volume: 2 μl  
 Extraction solvent: acetone

### ● Electrical contact failures

A number of substances have been reported to cause contact failures. Contact failures may be caused by organic materials such as human body oils and organic gases, or inorganic materials such as hydrogen

sulfide and ammonia gas.

Manufacturers of electrical and electronic equipment report that LMW siloxane can also cause contact failure at low voltages and low currents.

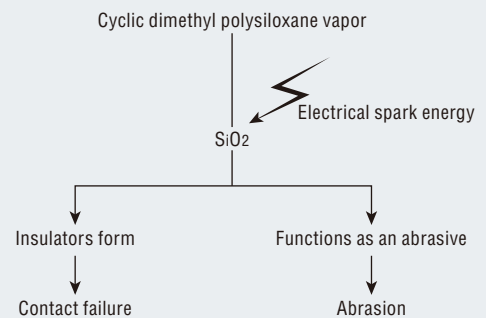
### ■ Relationship between load conditions and contact reliability

#### Effects of load on contact reliability (micro-relay)

Load			Si present on contact surfaces (Y/N)	Contact resistance
1	DC1 V	1 mA	N	No increase observed
2	DC1 V	36 mA	N	Increase of several ohms
3	DC3.5 V	1 mA	N	No increase observed
4	DC5.6 V	1 mA	Y	No increase observed
5	DC12 V	1 mA	Y	Increase of several ohms, some readings of infinity
6	DC24 V	1 mA	Y	Readings of infinity were seen at around 1,500 cycles; at 3,000 cycles, all were infinity
7	DC24 V	35 mA	Y	Readings of infinity were seen at around 3,000 cycles; at 4,500 cycles, all were infinity
8	DC24 V	100 mA	Y	No increase observed
9	DC24 V	200 mA	Y	No increase observed
10	DC24 V	1 A	Y	No increase observed
11	DC24 V	4 A	Y	No increase observed

[Test conditions] Switching frequency: 1 Hz, Temp.: room temperature, Contact force: 13 g  
 Source: The Institute of Electronics, Information and Communication Engineers, Yoshimura and Itoh EMC76-41 Feb. 18, 1977.

### ■ Mechanism of contact failure



The main ingredient of RTV silicone rubber is dimethyl polysiloxane HO-[Si(CH<sub>3</sub>)<sub>2</sub>O]<sub>n</sub>-H, which has a degree of polymerization between 200 and 1,000. The dimethyl polysiloxane obtained in the normal manufacturing process does contain small amounts of cyclic products. This cyclic dimethyl polysiloxane is nonreactive and volatile, and thus will vaporize into the air during the cure process and even after curing. Under certain conditions, this vaporized cyclic dimethyl polysiloxane can cause contact failures, according to the mechanism shown above.

# Main applications for RTV silicone rubber

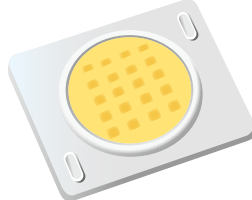
## LED devices

Endowed with high resistance to light and heat, silicone resins have a range of uses in various types of LEDs. Silicones used in LEDs include LED encapsulants, die-bonding adhesives and damming materials. LED encapsulants are used to protect the chips and wires, as a binder for the phosphors, and for molding light guides and lenses. Die-bonding adhesives are used to attach the chips, and damming materials are used for COB applications. The Shin-Etsu product line also includes reflective molding materials for LED packages.

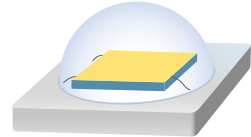
### SMD



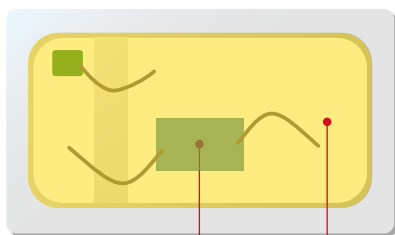
### High-density mounting



### Lens molding

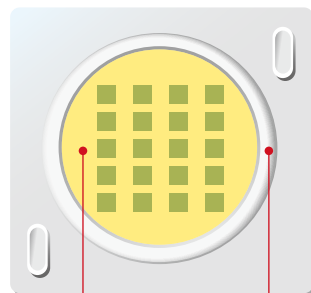
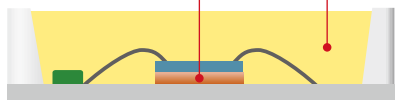


#### ■ Structural diagram



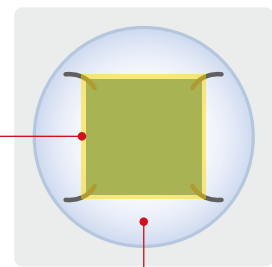
Die-bonding adhesive ▶ P24

Encapsulant +Phosphors ▶ P22-23



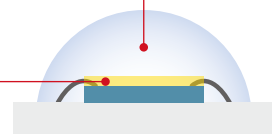
Encapsulant +Phosphors ▶ P22-23

Damming material ▶ P24



Encapsulant+Phosphors ▶ P22-23

Encapsulant ▶ P22-23

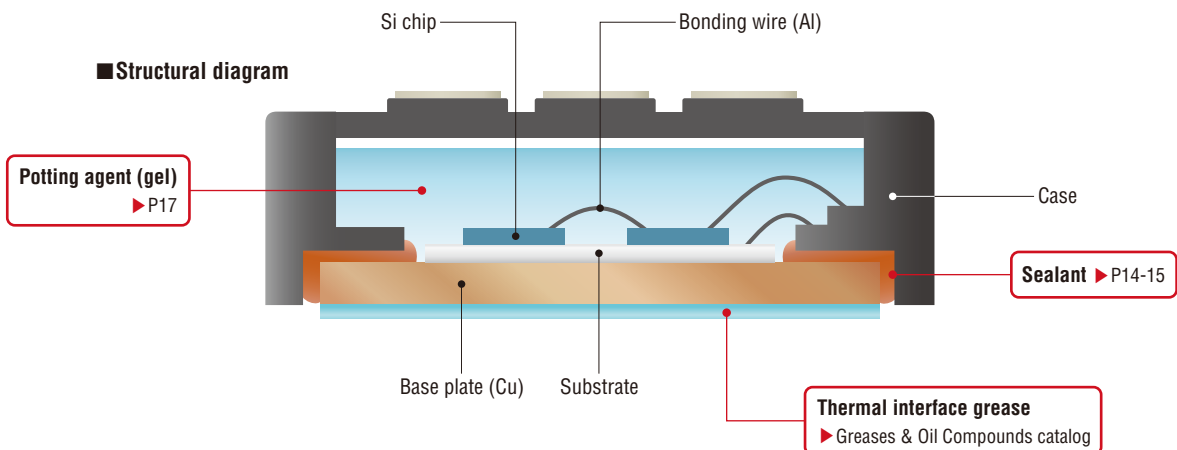


## IGBT Modules



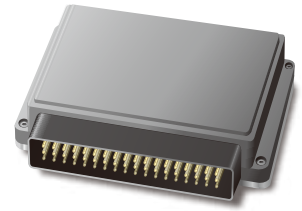
IGBT (Insulated Gate Bipolar Transistor) modules are a primary component of high-capacity inverters. In an IGBT module, a potting agent (gel) is used for electrical insulation and a sealant is used to bond the case to the base plate. In addition, a thermally conductive grease is used to help direct heat away from the IGBT module. For information on thermal interface greases, please see our Greases & Oil Compounds catalog.

#### ■ Structural diagram

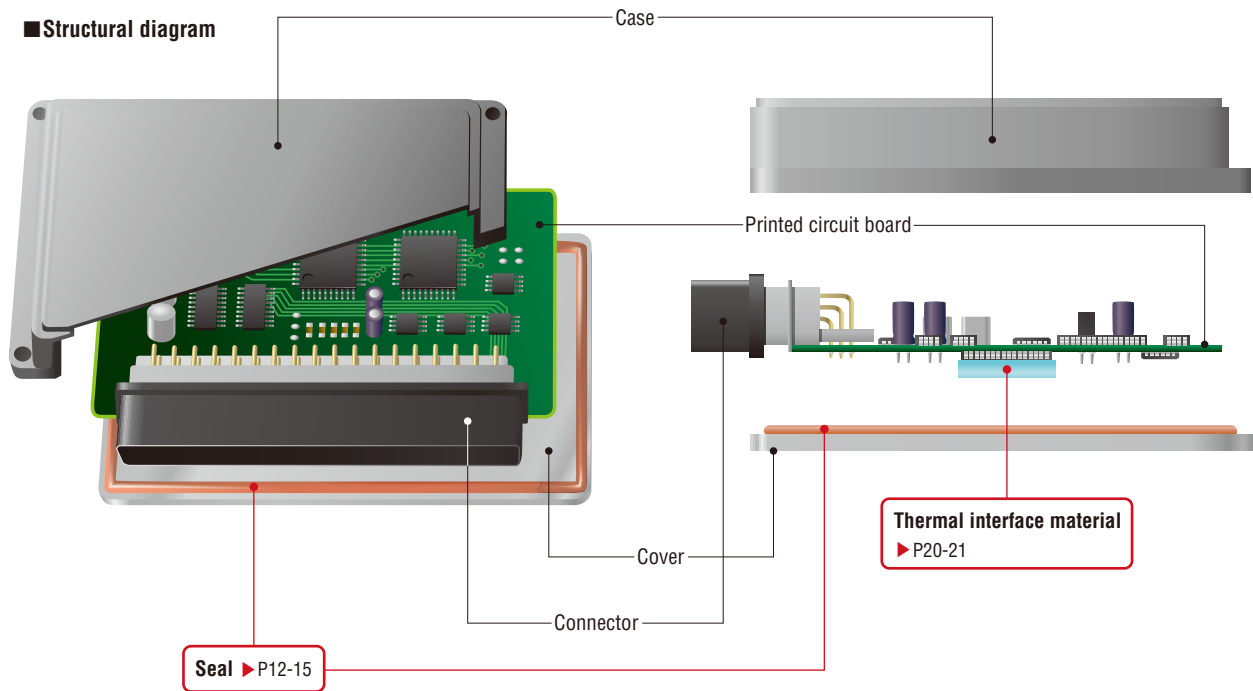


## ECUs

ECUs (Electronic Control Units) have played a critical role in improving automotive performance. Various types of ECUs are installed in automobiles, where they control the engine, steering system, braking system and sensors. RTV silicone rubber is used to seal the waterproof cases that house the ECUs and as a thermal interface material to aid in cooling the heat-producing components on circuit boards, helping to improve the reliability of the automobile. Silicone grease is also used as a thermal interface material. For information on thermal interface greases, please see our Greases & Oil Compounds catalog.



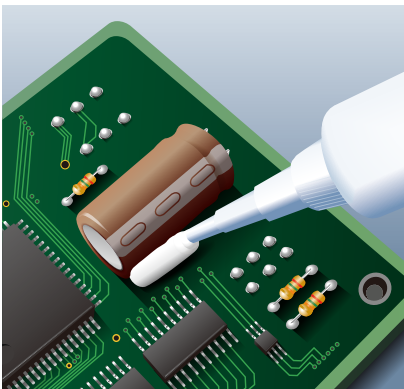
### ■ Structural diagram



## Circuit board assemblies

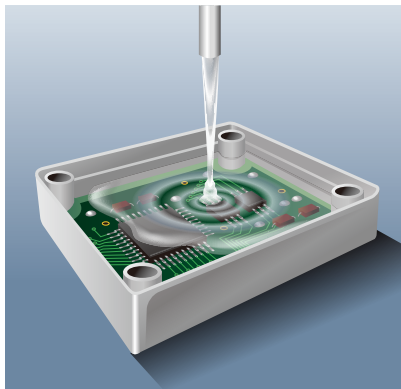
RTV silicone rubber is used for a variety of purposes in PCBs (Printed Circuit Boards). Sealants are used for bonding and attachment and as a thermal interface material for capacitors, transformers, coils and other electronic components. Potting agents are used to cover over the circuit board, where they provide waterproofing and electrical insulation and act as a thermal interface material. Coating agents are applied to part or all of the circuit board to protect components and circuits from moisture and metallic debris. And for power supply boards, which require a flame resistant material, products that meet UL94 V-0 requirements are used.

### Attaching components



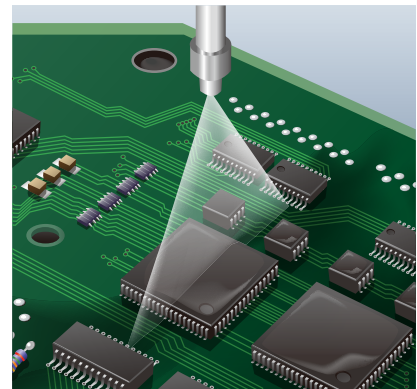
Sealants ▶ P12-13

### Potting circuit boards



Potting agents ▶ P16-17

### Coating circuit boards



Coating agents ▶ P18-19

# Product lists

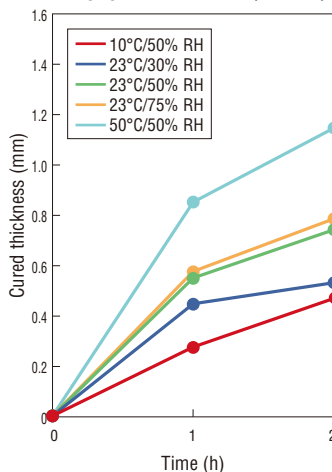
## Adhesives & Sealants

Cure system	One-component, condensation									
Product name	KE-3490	KE-3494	KE-3412	KE-4930-G	KE-4956-T	KE-4908-T	KE-4901-W	KE-4916-B	KE-4917-B	
Brief description	Flame resistant, for attachment of components	Flame resistant	High heat-resistant	Standard product	Standard product	High strength	Flame resistant, thermal interface material, for attachment of components	Flame resistant, thermal interface material	Sulfur barrier	
By-product gas	Acetone	Acetone	Acetone	Alcohol	Alcohol	Alcohol	Alcohol	Alcohol	Alcohol	
Before curing										
Consistency	Paste	Med. viscosity	Med. viscosity	Paste	Med. viscosity	Paste	Paste	Med. viscosity	Paste	
Appearance	Gray	Gray	Black	Gray	Translucent	Translucent	White	Black	Black	
Viscosity at 23°C	Pa·s	—	50	90	—	65	—	—	90	—
Tack-free time	min	3	8	6	7	14	20	8	7	20
Standard curing conditions	23 ± 2°C / 50 ± 5% RH × 7 days									
After curing										
Density at 23°C	g/cm <sup>3</sup>	1.18	1.40	1.06	1.36	1.03	1.08	1.59	1.62	1.58
Hardness Durometer A		43	35	40	30	30	40	53	62	50
Tensile strength	MPa	2.5	2.5	2.7	2.0	2.0	4.8	2.6	2.4	2.5
Elongation at break	%	350	250	270	350	300	600	120	60	130
Volume resistivity	TΩ·m	3.0	3.0	6.0	2.1	200	10	3.4	3.0	5.0
Dielectric breakdown strength	kV/mm	28	25	28	26	28	26	30	30	—
Relative permittivity 50 Hz		3.3	3.5	3.1	4.2	3.0	3.0	3.8	4.2	—
Dielectric dissipation factor 50 Hz		1 × 10 <sup>-2</sup>	1 × 10 <sup>-2</sup>	1 × 10 <sup>-2</sup>	4 × 10 <sup>-3</sup>	3.5 × 10 <sup>-3</sup>	1 × 10 <sup>-3</sup>	2 × 10 <sup>-1</sup>	1 × 10 <sup>-1</sup>	—
Thermal conductivity	W/m·K	0.25	0.42	0.21	—	—	0.21	0.75	0.82	0.75
Tensile lap-shear strength (Al/Al)	MPa	1.5	1.5	1.0	1.3 (PBT/PBT)	0.7	3.0	1.3	1.2	1.0
LMW siloxane content ΣD <sub>3</sub> -D <sub>10</sub>	ppm	< 300	< 300	< 300	< 300	< 300	—*	< 300	< 300	< 300
Flame resistance UL94		V-0	V-0	—	—	—	—	V-0	V-0	V-0

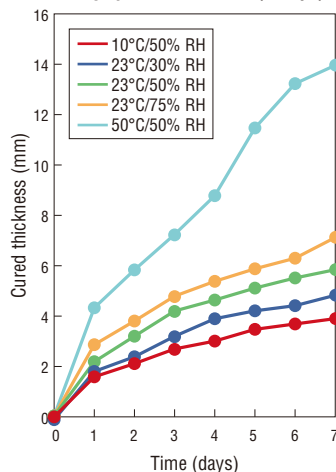
\* Not a reduced low-molecular-weight siloxane product.

(Not specified values)

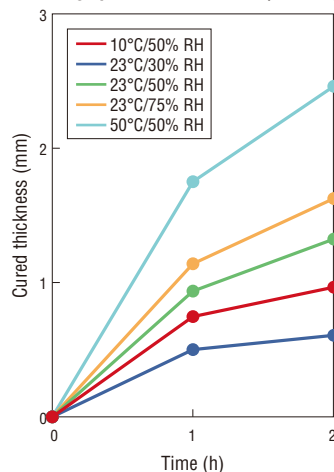
Effect of temperature & humidity on curing speed of KE-3490 (2 hours)



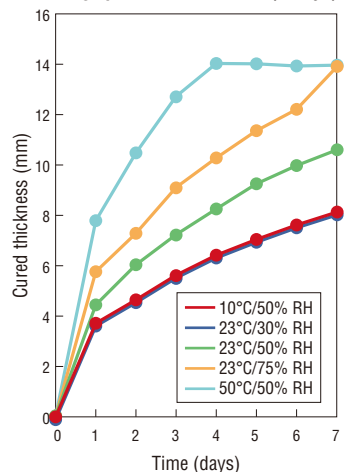
Effect of temperature & humidity on curing speed of KE-3490 (7 days)



Effect of temperature & humidity on curing speed of KE-3495-W (2 hours)



Effect of temperature & humidity on curing speed of KE-3495-W (7 days)



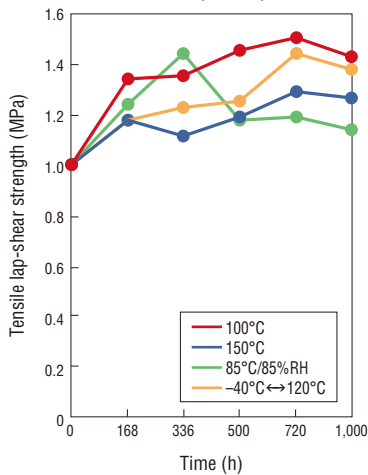
## Adhesives & Sealants

Cure system	One-component, condensation									
Product name	KE-4918-WHITE	KE-4918-WF	KE-4806-W	KE-4948-G	KE-3491	KE-3492	KE-3446-W	KE-3449-W	FE-2000	
Brief description	Flame resistant, thermal interface material, for attachment of components	Flame resistant, thermal interface material, for attachment of components	Filler*	Filler*	Electrically conductive	Electrically conductive	For masking	For masking	Oil and solvent resistant	
By-product gas	Alcohol	Alcohol	Alcohol	Alcohol	Acetone	Acetone	Acetone	Acetone	Alcohol	
Before curing										
Consistency	Paste	Paste	High viscosity	Paste	Paste	Paste	High viscosity	Paste	Paste	
Appearance	White	White	White	Gray	Black	Grayish black	White	White	Translucent	
Viscosity at 23°C	Pa·s	—	150	—	—	—	150	—	—	
Tack-free time	min	4	3	7	5	2	1	7	4	6
Standard curing conditions	23 ± 2°C / 50 ± 5% RH × 7 days									
After curing										
Density at 23°C	g/cm <sup>3</sup>	1.68	1.68	1.05	1.40	1.09	1.92	1.12	1.05	1.35
Hardness Durometer A		66	80	24	35	50	85	52	27	40
Tensile strength	MPa	2.3	3.5	1.5	2.0	3.3	2.7	5	2.6	1.9
Elongation at break	%	60	50	350	400	350	40	250	550	140
Volume resistivity	TΩ·m	7.0	4.5	40	1.1	5.0 × 10 <sup>-12</sup>	1.0 × 10 <sup>-15</sup>	—	—	—
Dielectric breakdown strength	kV/mm	29	27	24	30	—	—	—	—	—
Relative permittivity 50 Hz		3.9	4.1	3.1	3.8	—	—	—	—	—
Dielectric dissipation factor 50 Hz		2 × 10 <sup>-1</sup>	2 × 10 <sup>-1</sup>	1 × 10 <sup>-3</sup>	2 × 10 <sup>-1</sup>	—	—	—	—	—
Thermal conductivity W/m·K		0.88	0.85	—	—	—	—	—	—	—
Tensile lap-shear strength (Al/Al)	MPa	1.0	1.0 (Cu/Cu)	0.9 (Glass/Glass)	1.5	1.6	0.8	—	—	0.8
LMW siloxane content ΣD <sub>3</sub> -D <sub>10</sub>	ppm	< 300	< 300	< 500	—	< 300	< 300	—	—	—
Flame resistance UL94		V-0	V-0	—	V-0	—	—	—	—	—

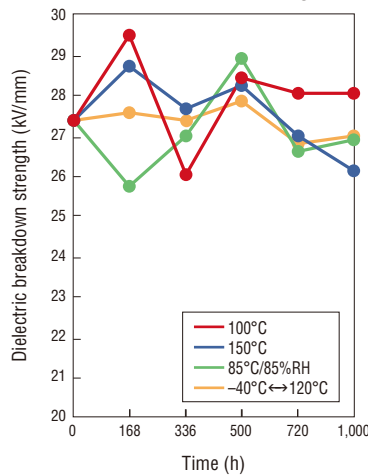
\* Will not inhibit curing of addition-cure RTV silicone rubbers.

(Not specified values)

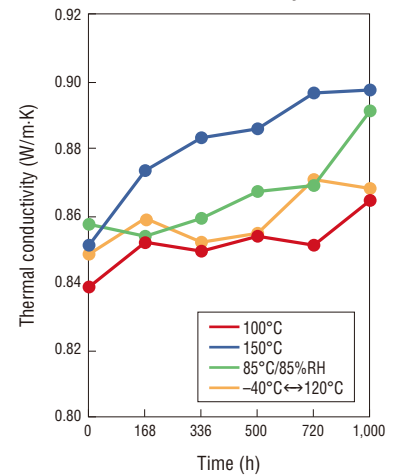
Endurance test result of KR-4918-WF Adhesion (Cu/Cu)



Endurance test result of KR-4918-WF Dielectric breakdown strength



Endurance test result of KR-4918-WF Thermal conductivity





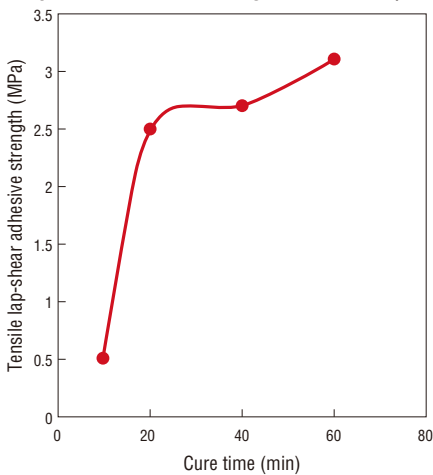
## ■ Adhesives & Sealants

Cure system	One-component, addition							
Product name	KE-1831	KE-1833	KE-1835-S	KE-1850	KE-1854	KE-1855	KE-1875	KE-1880
Brief description	Flame resistant	High heat-resistant	High adhesive strength	High heat-resistant	High heat-resistant, thixotropic	High adhesive strength	Reduced low-molecular-weight siloxane	High heat-resistant
Before curing								
Consistency	Paste	High viscosity	Paste	Paste	Paste	Paste	Paste	Med. viscosity
Appearance	Black	Reddish brown	White	Black	Black	Light gray	Black	Reddish brown
Viscosity at 23°C Pa·s	130	140	120	75	260	60	80	100
Standard curing conditions	120°C × 1 h							
After curing								
Density at 23°C g/cm <sup>3</sup>	1.28	1.36	1.25	1.26	1.25	1.28	1.06	1.25
Hardness Durometer A	33	33	40	26	30	66	27	33
Tensile strength MPa	3.9	3.4	4.0	2.6	3.5	6.4	2.4	4.0
Elongation at break %	400	330	370	320	480	170	390	350
Volume resistivity TΩ·m	2.0	2.0	11	—	—	5.0	1.0	—
Dielectric breakdown strength kV/mm	25	25	29	—	—	25	24	—
Relative permittivity 50 Hz	3.5	3.5	3.3	—	—	3.5	—	—
Dielectric dissipation factor 50 Hz	5 × 10 <sup>-3</sup>	5 × 10 <sup>-3</sup>	5 × 10 <sup>-3</sup>	—	—	5 × 10 <sup>-3</sup>	—	—
Thermal conductivity W/m·K	0.27	—	—	—	—	0.27	—	—
Tensile lap-shear strength (Al/Al) MPa	2.0	2.0	3.0	1.5	1.8	3.4 (PPS/PPS) 3.2 (PBT/PBT)	2.0	2.3
LMW siloxane content ΣD <sub>3</sub> -D <sub>10</sub> ppm	—*	—*	—*	—*	—*	—*	< 100	—*
Flame resistance UL94	V-0	—	HB	—	—	—	—	V-0

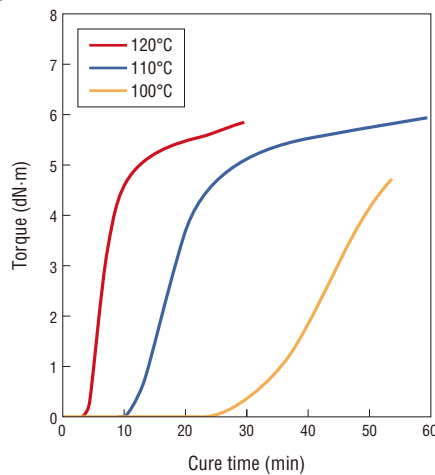
\* Not a reduced low-molecular-weight siloxane product.

(Not specified values)

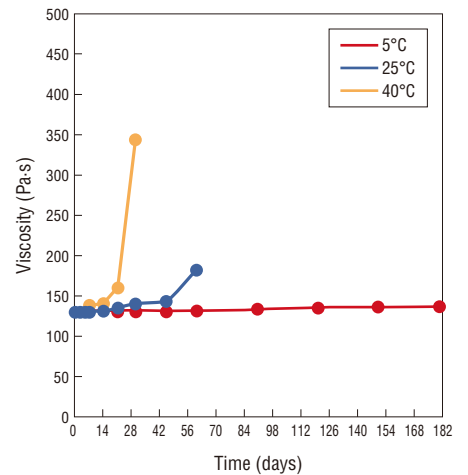
**Relationship between cure speed and lap-shear adhesive strength of KE-1833 (120°C)**



**Cure speed and temperature of KE-1833**



**Storage stability of KE-1833**



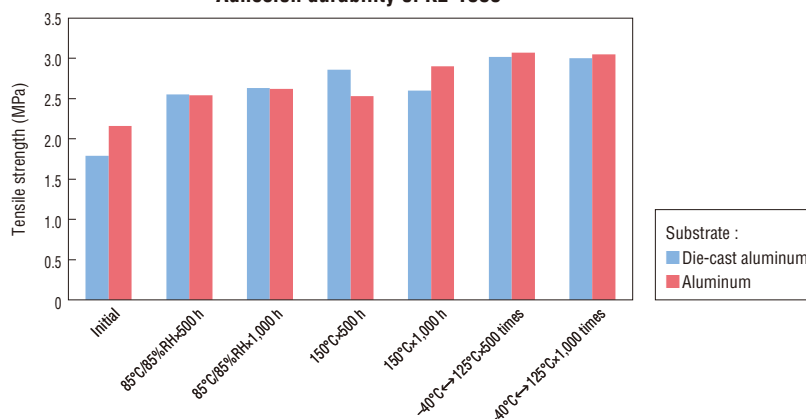
## Adhesives & Sealants

Cure system	One-component, addition						Two-component, addition	
Product name	KE-1812	KE-1884	KE-1885	IO-SEAL-300	KE-1849	FE-61	KE-1180-A/B	KE-1182-A/B
Brief description	Reduced low-molecular-weight siloxane	Low temperature cure, reduced low-molecular-weight siloxane	Low temperature cure, reduced low-molecular-weight siloxane	Countermeasure product against acid gas	Countermeasure product against electrical contact failure	Oil and solvent resistant	Low temperature cure	Room temperature cure
Before curing								
Consistency	Paste	Med. viscosity	High viscosity	Paste	High viscosity	Med. viscosity	Paste	Paste
Appearance	Translucent	White	White	White	White	Light gray	A:Pale yellow B:Creamy white	A:Pale yellow B:Creamy white
Viscosity at 23°C	Pa·s	—	55	100	50	100	60	A:158/B:57
Mix ratio	NA	NA	NA	NA	NA	NA	100:100	100:100
Mixed viscosity	Pa·s	NA	NA	NA	NA	NA	100	140
Pot life 23°C	min	NA	NA	NA	NA	NA	240	30
Tack-free time at 23°C	min	NA	NA	NA	NA	NA	360	90
Standard curing conditions	120°C × 1 h	100°C × 1 h			150°C × 1 h	120°C × 1 h	80°C × 1 h	23°C × 24 h
After curing								
Density at 23°C	g/cm <sup>3</sup>	1.05	1.22	1.14	1.23	1.29	1.43	1.07
Hardness Durometer A		23	35	36	31	74	25	21
Tensile strength	MPa	2.3	3.5	3.5	2.8	7.5	1.7	2.7
Elongation at break	%	400	230	300	270	160	170	580
Volume resistivity	TΩ·m	—	10	10	—	—	2.0*1	—
Dielectric breakdown strength	kV/mm	—	25	25	—	—	18	—
Relative permittivity 50 Hz		—	3.1	3.1	—	—	6.5	—
Dielectric dissipation factor 50 Hz		—	1 × 10 <sup>-3</sup>	1 × 10 <sup>-3</sup>	—	—	1 × 10 <sup>-2</sup>	—
Thermal conductivity	W/m·K	—	—	—	—	—	—	—
Tensile lap-shear strength (Al/Al)	MPa	1.2 (PBT/PBT)	1.9 (PBT/PBT)	2.0 (PBT/PBT)	1.5 (PPS/PPS)	3.4 (Fe/Fe)	0.6	2.4
LMW siloxane content ΣD <sub>3</sub> -D <sub>10</sub>	ppm	< 100	< 100	< 100	—*2	—*2	—*2	—*2
Flame resistance UL94		HB	—	—	HB	—	—	—

\*1 Unit: GΩ·m \*2 Not a reduced low-molecular-weight siloxane product.

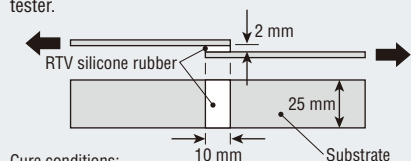
(Not specified values)

Adhesion durability of KE-1885



### Tensile lap-shear strength test method

RTV silicone rubber samples were cured as described in the figure, then tested using a lap-shear strength tester.



Cure conditions:  
 Condensation-cure type 23±2°C/50±5% RH × 7 days  
 Addition-cure type 120°C × 1 h  
 RTV silicone rubber thickness: 2 mm  
 Bonding surface: 10 × 25 mm  
 Pull rate: 50 mm/min

## ■ Potting agents (rubber)

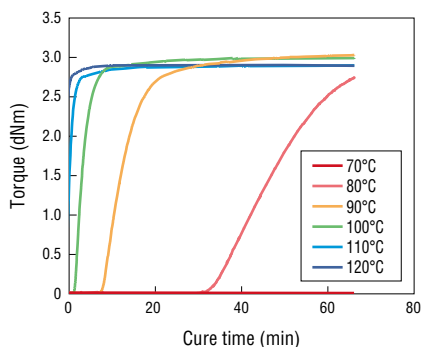
Cure system	Two-component, condensation	Two-component, addition									
Product name	KE-200★	KE1204 A/B	KE-1280-A/B	KE-1282-A/B	KE-1283-A/B*1	KE-1285-A/B	KE-1897-A/B	KE-1292-A/B	KE-109E-A/B	KE-106F	
Brief description	Rapid cure, good deep section curability, for PV	Flame resistant	Flame resistant, low specific gravity	Low stress, low volatile content	For LED displays	Flame resistant, thermal interface material	Flame resistant, high thermal interface material	Flame resistant, multi purpose applications	Low temperature cure, for LED lighting	Transparent, high strength	
By-product gas	Acetone	NA	NA	NA	NA	NA	NA	NA	NA	NA	
Before curing											
Consistency	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity
Appearance	Colorless translucent	A:Reddish brown B:Light gray	A:Black B:Creamy white	A:Black B:Light gray	A:Black B:Creamy white	A:Gray B:Light gray	A:Gray B:White	A:Black B:Light gray	A/B: Transparent	Transparent	
Viscosity at 23°C Pa·s	2.8	A:6/B:4	A:2/B:1.3	A:2.6/B:1.6	A:2.6/B:1.3	A:25/B:5	A:11/B:7	A:5.0/B:2.0	A/B:1	3.7	
Mix ratio	100:10	100:100	100:100	100:100	100:100	100:100	100:100	100:100	100:100	100:10	
Mixed viscosity Pa·s	2.2	5.0	1.7	2.1	1.5	9.0	9.0	3.0	1.0	2.6	
Pot life min	35*2	480*3	480*3	240*3	300*3	900*3	1,440 h*3	48 h*3	240*3	120*4	
Standard curing conditions	23 ± 2°C/ 50 ± 5% RH × 3 days	100°C × 15 min	120°C × 1 h	90°C × 2 h	80°C × 2 h	120°C × 1 h	120°C × 1 h	80°C × 2 h	100°C × 1 h	150°C × 30 min	
Curing agent	CX-200	NA	NA	NA	NA	NA	NA	NA	NA	CAT-106F	
After curing											
Density at 23°C g/cm <sup>3</sup>	1.01	1.54	1.01	1.32	0.96	1.72	2.61	1.48	1.00	1.02	
Hardness Durometer A	25	70	24	11	10 (Asker C)	56	20	37	25	52	
Tensile strength MPa	0.4	3.5	0.6	0.7	0.2	2.8	0.4	1.8	1.3	5.9	
Elongation at break %	100	70	140	160	300	140	100	140	140	100	
Volume resistivity TΩ·m	60	1.0	1.0	1.0	1.0	6.5	0.2	13	6.0	56	
Dielectric breakdown strength kV/mm	20	27	25	24	25	26	25	30	23	29	
Relative permittivity 50 Hz	2.9	3.2	4.1	3.2	4.0	4.0	6.0	3.0	2.8	3.0	
Dielectric dissipation factor 50 Hz	3 × 10 <sup>-3</sup>	1 × 10 <sup>-3</sup>	1 × 10 <sup>-3</sup>	1 × 10 <sup>-3</sup>	1 × 10 <sup>-3</sup>	1 × 10 <sup>-2</sup>	6 × 10 <sup>-3</sup>	8 × 10 <sup>-3</sup>	6 × 10 <sup>-4</sup>	3 × 10 <sup>-4</sup>	
Thermal conductivity W/m·K	0.21	0.58	0.25	0.40	0.25	0.80	1.60	0.55	0.15	—	
Tensile lap-shear strength (Al/Al) MPa	0.4	—	0.2	0.4	0.2	1.5	0.3	0.6 (Glass epoxy)	0.2	—	
LMW siloxane content ΣD <sub>3</sub> -D <sub>10</sub> ppm	< 300	< 500	—*5	< 500	—*5	< 500	< 500	< 300	—*5	—*5	
Flame resistance UL94	V-1	V-0	V-0	—	V-1	V-0	V-0	V-0	—	—	

\*1 Can be made a matte color by adding Liquid C \*2 Time to reach non-fluid state \*3 Time until viscosity doubles

\*4 Finger touch \*5 Not a reduced low-molecular-weight siloxane product. ★ KE-200 is also available in a fast-curing formulation (KE-200F).

(Not specified values)

Cure property of KE-1897-A/B



Type MP-202 KN-J

- For potting agents with high filling levels
- High durability against fillers
- Continuous metering by way of progressive cavity pump system
- Fine control over discharge quantity via timer

Type EX-202NP

- For potting agents without fillers
- Continuous metering by way of gear pump system
- Fine control over discharge quantity via timer
- Very low running cost



● Made by Nippon Sosey Kogyo corporation <http://www.sesey.com/>

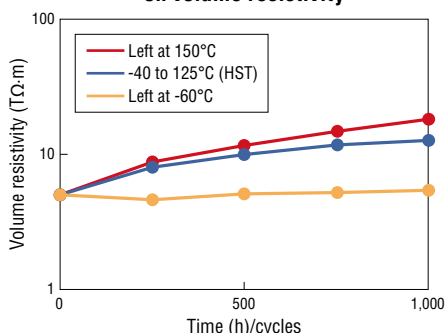
## ■ Potting agents (gel)

Cure system	One-component, addition					Two-component, addition				
Product name	KE-1056	KE-1057	KE-1061	KE-1062	FE-73	KE-1012-A/B	KE-1013-A/B	KE-1051J-A/B	KE-1063-A/B	FE-77-A/B
Brief description	Cold resistant	Standard product	Cold resistant, low viscosity	High heat-resistant, cold resistant	Oil and solvent resistant	Standard product	For use as a binder	Room-temperature curing, high adhesion	High heat-resistant, cold resistant, high adhesion	Oil and solvent resistant
Before curing										
Consistency	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	A/B: Low viscosity	A/B: Low viscosity	A/B: Low viscosity	A/B: Low viscosity	A/B: Low viscosity
Appearance	Colorless slightly cloudy	Colorless transparent	Colorless transparent	Pale yellow slightly cloudy	Colorless slightly cloudy	A/B: Colorless transparent	A/B: Colorless transparent	A/B: Colorless transparent	A/B: Pale yellow slightly cloudy	A/B: Colorless transparent
Viscosity at 23°C	mPa·s	800	800	600	700	2,000	A:1,000/ B:800	A:400/ B:380	A:900/ B:600	A:900/ B:600
Mix ratio	NA	NA	NA	NA	NA	NA	100:100	100:100	100:100	100:100
Mixed viscosity	NA	NA	NA	NA	NA	NA	900	400	800	800
Density at 25°C	0.98	0.97	0.97	0.99	1.28	A/B:0.97	A/B:0.97	A/B:0.97	A/B:0.99	A/B:1.22
Pot life	min	NA	NA	NA	NA	NA	240	120	60	240
Standard curing conditions	130°C × 30 min	150°C × 30 min	120°C × 30 min		125°C × 2 h	110°C × 30 min	120°C × 1 h	23°C × 24 h	23°C × 24 h	100°C × 2 h
After curing										
Penetration 1/4 cone	90	65	90	40	65	50	60	65	60	65
Tensile strength	MPa	NA	NA	NA	NA	NA	NA	NA	NA	NA
Elongation at break	%	NA	NA	NA	NA	NA	NA	NA	NA	NA
Volume resistivity	TΩ·m	8.0	10	3.0	2.0	0.02	8.0	5.0	10	8.0
Dielectric breakdown strength	kV/mm	14	14	14	14	14	14	14	14	14
Relative permittivity 50 Hz	3.0	3.0	3.0	3.0	7.0	3.0	3.0	3.0	3.0	7.0
Dielectric dissipation factor 50 Hz	$5 \times 10^{-4}$	$5 \times 10^{-4}$	$5 \times 10^{-4}$	$5 \times 10^{-4}$	$1 \times 10^{-2}$	$5 \times 10^{-4}$	$5 \times 10^{-4}$	$5 \times 10^{-4}$	$5 \times 10^{-4}$	$1 \times 10^{-2}$
Thermal conductivity	W/m·K	0.20	0.20	0.20	0.20	0.20	0.20	0.20	0.20	0.20
Complex shear modulus 10 Hz	Pa	2,200	2,000	1,500	15,000	6,500	6,500	2,900	23,000	13,000
LMW siloxane content $\Sigma D_{3-D_{10}}$	ppm	—*	—*	—*	—*	—*	—*	< 300	—*	—*

\* Not a reduced low-molecular-weight siloxane product.

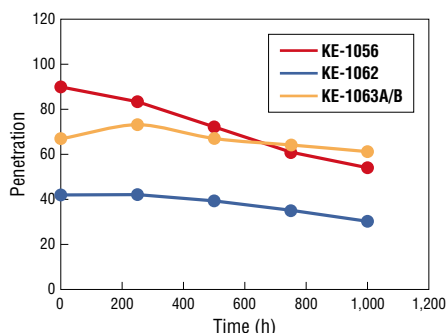
(Not specified values)

**KE-1056: Effects of various types of aging on volume resistivity**



\* HST (Heat Shock Test) conditions: -40°C (30 min) ↔ 125°C (30 min) / cycle

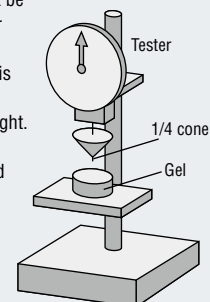
**Heat resistance of silicone gels (200°C)**



### Hardness (penetration)

Silicone gels have moduli of elasticity of  $10^5$  Nm/m<sup>2</sup> or less, and thus cannot be measured with a regular rubber hardness tester. Hardness (penetration) is normally measured as shown in the figure at right. There is a correlation between penetration and modulus of elasticity.

Measurement method  
Penetration test:  
JIS K 2220, 1/4 cone  
Total load: 9.38 g



## Coating agents

Cure system	One-component, condensation							
Product name	KE-4920-T*	KE-4920-W	KE-4920-B	KE-4921-W	KE-4970	KE-4971	KE-4914-G	KST-647
Brief description	Conformal coating	Conformal coating	Conformal coating	Conformal coating	Conformal coating	Conformal coating	Flame resistant, conformal coating	High hardness, conformal coating
By-product gas	Alcohol	Alcohol	Alcohol	Alcohol	Alcohol	Alcohol	Alcohol	Acetone
Before curing								
Consistency	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Liquid
Appearance	Pale yellow transparent	White	Black	White	Pale yellow transparent	Pale yellow transparent	Gray	Pale yellow transparent
Viscosity at 23°C Pa·s	1.5	3.7	3.5	0.9	0.25	0.6	3.0	0.04
Tack-free time min	7	8	7	5	20	5	20	8*1
Non-volatile content 105°C × 3 h %	96	—	—	—	83	96	94	68*2
Standard curing conditions	23 ± 2°C / 50 ± 5% RH × 7 days							
After curing								
Density at 23°C g/cm <sup>3</sup>	0.98	1.02	1.00	1.01	0.98	0.98	1.13	1.13
Hardness Durometer A	25	23	26	30	34*3	20	27	77
Tensile strength MPa	0.5	1.0	1.0	0.5	—	—	0.8	2.5
Elongation at break %	150	210	200	70	—	—	100	500
Volume resistivity TΩ·m	12	—	—	—	10	10	3	200
Dielectric breakdown strength kV/mm	23	—	—	—	28	30	30	23
Relative permittivity 50 Hz	2.9	—	—	—	2.4	1.9	3.0	3.1
Dielectric dissipation factor 50 Hz	4 × 10 <sup>-3</sup>	—	—	—	1 × 10 <sup>-3</sup>	6 × 10 <sup>-3</sup>	3 × 10 <sup>-2</sup>	2 × 10 <sup>-3</sup>
Thermal conductivity W/m·K	0.17	—	—	—	—	—	—	—
Tensile lap-shear strength (Glass/Glass) MPa	—	—	—	0.2	—	—	0.3	—
LMW siloxane content ΣD <sub>3</sub> -D <sub>10</sub> ppm	< 300	< 300	< 300	< 300	< 300	< 300	< 300	—
Flame resistance UL746E	—	—	—	—	V-0	V-0	—	—
Flame resistance UL94	—	—	—	—	—	—	V-0	—

\*1 Film thickness=200 μm \*2 This product is diluted with isoparaffin.

\*3 Tested using 6 stacked 1 mm sheets (not in accordance with JIS K 6249)

\*4 50-165 μm on FR-4

★ KE-4920-T is also available in a UV fluorescent formulation (KE-4920-TUV).

(Not specified values)



### Curtain coating valve CV-12

- Avoid coating of unwanted areas  
Sharply defined edges with no overspray
- Suitable viscosities: 1–100 mPa·s

### Desktop coating system SM300SX-4A+CV-12

- Exceptional control over coating thickness
- No masking required  
Useful coating pattern editing function

### Fully automated board coating system COATING MASTER FCD1000

- For precision coating  
Handles coating of complex topographies in high-density mounting applications
- Features a dual head for switching between curtain coating and spot coating



● Made by Musashi Engineering Inc. <http://www.musashi-engineering.co.jp.e.cn.hp.transer.com/>



## Coating agents

Cure system	One-component, condensation				One-component, addition			
Product name	KE-3495	KE-3424-G	KE-3456	KE-3476-T	KE-1844	KE-1846	KE-1886	KE-1871
Brief description	Rapid cure	Reduced low-molecular-weight siloxane, UL certified, electrode coating agent	Sulfur barrier	Rapid cure	Low viscosity	Low temperature cure, reduced low-molecular-weight siloxane	Low temperature cure, reduced low-molecular-weight siloxane	Heat resistant
By-product gas	Acetone	Acetone	Acetone	Acetone	NA	NA	NA	NA
Before curing								
Consistency	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity	Low viscosity
Appearance	Translucent / white	Gray	Pale yellow transparent	Translucent	Blue	Creamy white	Creamy white	Pale yellow translucent
Viscosity at 23°C Pa·s	5.5	20	0.7	11	1.2	7.0	14	0.9
Tack-free time min	11	6	4	6	NA	NA	NA	NA
Standard curing conditions	23 ± 2°C / 50 ± 5% RH × 7 days				150°C × 30 min	100°C × 1 h	100°C × 1 h	150°C × 30 min
After curing								
Density at 23°C g/cm <sup>3</sup>	1.03	1.32	1.03	—	1.04	1.02	1.03	1.01
Hardness Durometer A	30	50	17	25	23	25	29	27
Tensile strength MPa	1.1	4.0	0.3	1.2	1.7	3.0	2.9	2.2
Elongation at break %	200	180	90	240	160	180	160	180
Volume resistivity TΩ·m	4.0	40	10	—	18	1.0	10	29
Dielectric breakdown strength kV/mm	20	22	26	—	28	25	25	27
Relative permittivity 50 Hz	2.8	3.6	2.6	—	2.7	—	3.1	2.9
Dielectric dissipation factor 50 Hz	3 × 10 <sup>-3</sup>	8.8 × 10 <sup>-3</sup>	4 × 10 <sup>-4</sup>	—	1 × 10 <sup>-3</sup>	—	1 × 10 <sup>-3</sup>	2 × 10 <sup>-4</sup>
Thermal conductivity W/m·K	0.21	0.40	—	—	—	—	—	—
Tensile lap-shear strength (Al/Al) MPa	0.3	0.4	—	—	0.3	0.3	0.6 (PBT/PBT)	0.2
LMW siloxane content ΣD <sub>3</sub> -D <sub>10</sub> ppm	< 300	< 300*1	< 300	—	—*2	< 100	< 100	—*2
Flame resistance UL94	—	V-1	—	—	—	—	—	—

\*1 KE-3424-G is a high grade product with a ΣDn (n: 3–20) content of less than 300 ppm.

\*2 Not a reduced low-molecular-weight siloxane product.

(Not specified values)

### SC-300 Swirl Coat valve

- Suitable for silicone-based and other types of solventless coating agents
- Handles a wide range of viscosities (30–3,500 cps)



### Anti-sulfurization test

#### Test method

1. Sulfur powder is put in an airtight container.
2. A conformal coating is applied in a 200 μm thick layer to a silver substrate. Once the coating cures completely, the test specimen is placed in the container in "1" above.
3. The specimen is placed in a 50°C oven, and the silver substrate is checked for discoloration.

#### Comparison between KE-3456 and conventional product (Coating thickness 200 μm)

KE-3456 offers excellent protection against sulfurization.



## Thermal interface materials

Cure system	One-component, condensation					One-component, addition				
Product name	KE-3467	KE-4961-W	KE-4962-W	G-1000	KE-4967-W	KE-1867	KE-1869	KE-1891	G-789	
Brief description	Flame resistant, high thermal interface material	Flame resistant	High thermal interface material	Low hardness, high thermal interface material	Thermal interface material, reworkability	Flame resistant, high thermal interface material	Low hardness, cold resistant	Flame resistant, high thermal interface material	High thermal interface material, low thermal resistance, reworkable	
By-product gas	Acetone	Alcohol	Alcohol	Acetone	Alcohol	NA	NA	NA	NA	
Before curing										
Consistency	High viscosity	Paste	Paste	Paste	Paste	Med. viscosity	Med. viscosity	Paste	Grease	
Appearance	White	White	White	White	White	Gray	Grayish white	Grayish white	White	
Viscosity at 23°C	Pa·s	100	—	—	80	250	70	30	—	180* <sup>1</sup>
Tack-free time	min	4	1	2	3	11	NA	NA	NA	NA
Standard curing conditions	23 ± 2°C / 50 ± 5% RH × 7 days					120°C × 1 h			125°C × 1.5 h	
After curing										
Density at 23°C	g/cm <sup>3</sup>	2.90	2.34	2.65	3.04	2.45	2.92	2.52	3.06	3.20
Hardness Durometer A		91	80	88	40 (Asker C)	60	75	30 (Penetration* <sup>2</sup> )	96	10 (Asker C)
Tensile strength	MPa	3.6	3.9	4.4	—	1.5	2.1	NA	5.3	NA
Elongation at break	%	30	60	30	—	100	60	NA	10	NA
Volume resistivity	TΩ·m	5.9	1.0	1.0	—	—	1.2	3.0	3.4	—
Dielectric breakdown strength	kV/mm	25	24	25	14	—	23	24	25	—
Relative permittivity 50 Hz		4.6	4.3	—	—	—	6.7	5.3	—	—
Dielectric dissipation factor 50 Hz		4×10 <sup>-3</sup>	1×10 <sup>-1</sup>	—	—	—	4.5×10 <sup>-3</sup>	2×10 <sup>-3</sup>	—	NA
Thermal conductivity	W/m·K	2.4	1.6	2.4	2.4	1.1	2.2	1.1	4.0	3.0
Tensile lap-shear strength (Al/Al)	MPa	0.5	0.7	0.8	—	—	0.8	NA	0.8	NA
LMW siloxane content ΣD <sub>3</sub> -D <sub>10</sub>	ppm	< 300	< 300	< 300	< 100	—* <sup>3</sup>	< 300	—* <sup>3</sup>	< 300	—* <sup>3</sup>
Flame resistance UL94		V-0	V-0	—	—	—	V-0	—	V-0	—

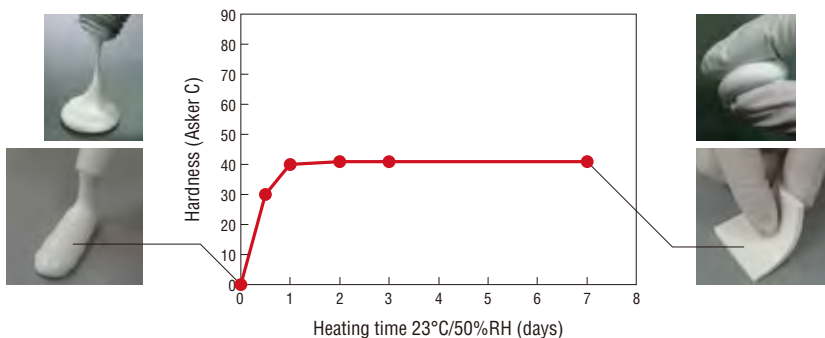
\*1 Malcom viscometer 10 rpm

\*2 Penetration: 1/4 cone

\*3 Not a low-molecular-weight siloxane product.

(Not specified values)

Cure property of G-1000 (Thickness: 2.0 mm)



\* Sheets of 2.0 mm thickness are cured at 23°C/50% RH for a prescribed amount of time.

The cured sheets are then stacked to a thickness 10 mm (min.), and a hardness tester (Asker C) is used to measure hardness.

## Thermal interface materials

Cure system	Two-component, addition										UV+addition
Product name	KE-1184-A/B	KE-1897-A/B	KE-1898-A/B	KE-1899-A/B	SDP-1030-A/B	SDP-2060-A/B	SDP-3540-A/B	SDP-5040-A/B	SDP-6560-A/B	GUV-300	
Brief description	Room temperature rapid cure, adhesion	Flame resistant, low viscosity	Flame resistant, low viscosity, high thermal interface material	Flame resistant, low viscosity, high thermal interface material	Room temperature cure, reworkability	Room temperature cure, reworkability	Room temperature cure, reworkability	Room temperature cure, reworkability	Room temperature cure, reworkability	UV cure, high thermal interface material	
Before curing											
Consistency	Paste	Low viscosity	Low viscosity	Low viscosity	Grease	Grease	Grease	Grease	Grease	Grease	
Appearance	A/B: Grayish white	A:Gray B:White	A:Gray B:White	A:Gray B:White	A:White B:Pale blue	A:White B:Pale blue	A:White B:Gray	A:Grayish white B:Pink	A:Grayish white B:Pink	White	
Viscosity at 23°C Pa·s	A:50/B:40	A:11/B:7	A:22/B:14	A:26/B:17	A:102/B:55*2	A:99/B:71*2	A:103/B:72*2	A:181/B:162*2	A:282/B:288*2	154*2	
Mix ratio	100:100										—
Mixed viscosity at 23°C Pa·s	45	9.0	15	20	74*2, *3	81*2, *3	89*2, *3	169*2, *3	284*2, *3	—	
Tack-free time min	30	NA	NA	NA	360	360	360	360	360	—	
Pot life at 23°C min	5	7,000*1	7,000*1	7,000*1	240	240	240	240	240	NA	
Specific gravity at 25°C	—	—	—	—	A/B:2.45	A/B:2.87	A:3.08/B:3.07	A:3.25/B:3.26	A/B=3.20/3.20	2.98	
UV irradiation conditions mJ/cm <sup>2</sup>	—	—	—	—	—	—	—	—	—	6,000*4	
Standard curing conditions	23°C × 24 h	120°C × 1 h			25°C × 24 h					25°C × 1 h*5	
After curing											
Density at 23°C g/cm <sup>3</sup>	2.78	2.61	2.86	2.99	2.43	2.84	3.09	3.27	3.34	—	
Hardness	Durometer A	48	20	22	16	—	—	—	—	—	
	Shore OO	NA	NA	—	NA	32	57	44	42	61	
	Asker C	NA	NA	—	NA	10	25	17	16	30	
Flexural modulus G <sup>1</sup> (t=0.2 mm) Pa	NA	NA	NA	NA	NA	NA	NA	NA	NA	38,730	
Tensile strength MPa	0.9	0.4	0.4	0.3	0.3	0.3	0.1	0.1	0.1	NA	
Elongation at break %	60	100	60	60	480	70	40	30	20	NA	
Volume resistivity TΩ·m	0.25	0.2	6.0	3.4	0.023	0.025	0.018	0.031	0.028	—	
Dielectric breakdown strength kV/mm	23	25	19	17	19	18	20	21	20	—	
Thermal conductivity W/m·K	2.0	1.6	2.2	2.9	1.1	2.3	3.5	5.1	6.5	3.1	
Tensile lap-shear strength (Al/Al) MPa	0.6	0.3	0.3	0.2	—	—	—	—	—	—	
LMW siloxane content ΣD <sub>3</sub> -D <sub>10</sub> ppm	< 300	< 500	—	< 500	< 300	< 300	< 300	< 300	< 300	< 300	
Flame resistance UL94	—	V-0	V-0 equivalent	V-0 equivalent	V-0 equivalent	V-0 equivalent	V-0 equivalent	V-0 equivalent	V-0 equivalent	NA	

\*1 Time until viscosity doubles \*2 Malcom viscometer 10 rpm \*3 25°C \*4 UV irradiation device : metal halide lamp \*5 Standard curing conditions after UV irradiation

(Not specified values)



### PD-B

- Compact, low cost, simple-to-use standard model
- Does not use cleaning agent, which means no maintenance required



### ECO-FLOW-R

- Volumetric metering, mixing and dispensing of two-component products directly from buckets Helps reduce material loss.
- Features a Twin Rotary Ratio Valve to ensure consistent discharge volume



### Two-component servo plunger unit

- Two-component dispenser equipped with plunger pumps for precision application of small amounts
- Lightweight, compact, and features a static mixer that requires no cleaning

●Made by Naka Liquid Control Co., Ltd. <http://www.nlc-dis.co.jp/english/company/index.html>

## LED encapsulants

Cure system		Two-component, addition								
Product name	KER-2500-A/B	KER-2600-A/B	KER-2910-A/B	KER-2937-A/B	KER-2938-A/B	KER-6150-A/B	KER-6200-A/B	FER-7061-A/B	FER-7110-A/B	
Brief description	High heat resistant	Med. hardness, for lighting	Ultra high heat resistant, for lighting	Ultra high heat resistant, for lighting	Ultra high heat resistant, for lighting	Med. refractive index	High refractive index, gel	Low refractive index	Low refractive index	
Category	Methyl rubber					Phenyl rubber	Phenyl gel	Fluoro rubber		
Before curing										
Appearance	A/B: Colorless transparent	A/B: Colorless transparent	A/B: Colorless transparent	A:Pale yellow transparent B:Colorless transparent	A:Pale yellow transparent B:Colorless transparent	A:Colorless to pale yellow transparent B:Colorless transparent to creamy white translucent	A/B: Pale yellow transparent	A/B: Colorless transparent	A/B: Colorless transparent	
Viscosity at 23°C mPa·s	A:8,300/ B:2,700	A:6,500/ B:5,500	A:5,280/ B:4,200	A:19,500/ B:3,700	A:24,400/ B:2,600	A:5,000/ B:2,000	A:1,600/ B:1,400	A:14,000/ B:1,650	A:40,000/ B:2,000	
Mix ratio	100:100	100:100	100:100	100:100	100:40	100:100	100:100	20:80	20:80	
Mixed viscosity at 23°C mPa·s	4,300	6,000	4,800	4,000	5,700	3,000	1,400	2,100	3,600	
Density at 23°C g/cm <sup>3</sup>	A/B:1.06	A/B:1.02	A:0.98/B:1.00	A:1.02/B:0.97	A:1.02/B:0.97	A/B:1.08	A/B:1.08	A:1.40/B:1.35	A/B:1.52	
Refractive index 23°C/589 nm	A/B:1.41	A/B:1.41	A/B:1.41	A/B:1.41	A/B:1.41	A/B:1.44	A/B:1.50	A/B:1.38	A/B:1.36	
Pot life at 23°C h	24	24	8	8	8	24	3	8	8	
Standard curing conditions	100°C × 1 h + 150°C × 2 h									
After curing										
Hardness	Shore D	NA	NA	NA	NA	NA	NA	30	NA	NA
	Durometer A	70	47	20	48	70	50	(Penetration)	65	40
Flexural modulus MPa	—	—	—	—	—	—	—	—	—	
Flexural strength MPa	—	—	—	—	—	—	—	—	—	
Tensile strength MPa	10.0	6.0	0.6	7.0	11.3	5.7	NA	1.6	0.5	
Elongation at break %	100	150	240	190	90	70	NA	50	30	
Light transmissivity 400 nm/2 mm %	92	92	93	90	91	92	98*	92	93	
Softening point °C	NA	—	-40	NA	NA	NA	-40	-60	-30	
Coefficient of linear expansion ppm	α1	—	—	—	—	—	—	—	120	130
	α2	250	390	560	340	270	310	350	310	330
Volume resistivity TΩ·m	16	10	—	—	—	—	0.5	7.2	2.1	
Dielectric breakdown strength kV/mm	25.0	26.0	—	—	—	—	15.0	21.0	23.0	
Relative permittivity 50Hz	3.2	3.2	—	—	—	—	3.1	5.3	3.8	
Dielectric dissipation factor 50 Hz	7 × 10 <sup>-3</sup>	5 × 10 <sup>-3</sup>	—	—	—	—	4 × 10 <sup>-4</sup>	1 × 10 <sup>-1</sup>	1 × 10 <sup>-1</sup>	
Adhesion strength MPa	PPA	3.0	2.4	0.3	0.6	1.6	0.8	NA	0.6	0.2
	Silver	1.4	2.0	0.3	—	—	0.7	NA	0.6	0.2
Moisture absorption 85°C/85%RH/24 h %	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	—	< 0.1	< 0.1
Water absorption 40°C/24 h %	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	—	< 0.1	< 0.1
Oxygen permeability cc/m <sup>2</sup> ·day	31,000 (0.92 mm)	35,000 (0.92 mm)	—	—	—	19,600 (0.95 mm)	—	4,700 (0.95 mm)	10,000 (0.95 mm)	

\* Optical path length: 10 mm. Measured in a quartz cell.

(Not specified values)

## LED encapsulants

Cure system		Two-component, addition					One-component, addition			
Product name	ASP-1120-A/B	ASP-2010-A/B	ASP-2020-A/B	SCR-1012 A/B-R	SCR-1016 A/B	SCR-1018A (S2)/B	KER-6075-F	KER-6020-F	KER-6230-F	
Brief description	High refractive index, low stress, rubber type	High hardness, crack resistant	For molding	Low gas permeability	Low gas permeability	Low gas permeability, thixotropic	Thixotropic	For metal protection, thixotropic	For photocoupler, thixotropic	
Category	Phenyl rubber	Phenyl resin	Phenyl rubber	Modified silicone			Phenyl rubber		Phenyl gel	
Before curing										
Appearance	A:Colorless to pale yellow transparent B:Colorless transparent to creamy white translucent	A/B:Colorless transparent to pale yellow transparent	A/B:Colorless transparent to pale yellow transparent	A/B-R: Colorless transparent to pale yellow	A/B: Colorless transparent to pale yellow	A:White to creamy white B:Colorless transparent to pale yellow	Creamy white translucent	Creamy white translucent	Creamy white translucent	
Viscosity at 23°C	mPa·s	A:1,600/ B:160	A:2,000/ B:2,500	A:7,000/ B:3,500	A:13,000/ B:1,200*	A:12,000/ B:35*	A:18,000/ B:35*	34,000 (Non-fluid)	33,000 (Non-fluid)	33,000
Mix ratio		100:100	20:80	10:90	100:100	100:100	100:100	NA	NA	NA
Mixed viscosity at 23°C	mPa·s	450	2,300	3,600	3,400*	260*	600*	NA	NA	NA
Density at 23°C	g/cm <sup>3</sup>	A:1.12/B:1.10	A:1.13/B:1.14	A:1.13/B:1.16	A:0.99/B:1.03*	A:0.99/B:1.05*	A:1.04/B:1.05*	1.14	1.05	1.04
Refractive index	23°C/589 nm	A:1.58/B:1.53	A:1.59/B:1.55	A:1.57/B:1.54	A:1.54/B:1.47*	A:1.54/B:1.51*	A:1.54/B:1.51*	1.44	1.43	1.42
Pot life at 23°C	h	24	8	8	8*	8*	8*	NA	NA	NA
Standard curing conditions		100°C × 2 h + 150°C × 4 h			100°C × 1 h + 150°C × 5 h			100°C × 1 h + 150°C × 2 h	150°C × 1 h	130°C × 30 min
After curing										
Hardness	Shore D	NA	55	NA	76	71	73	NA	NA	40 (Penetration)
	Durometer A	65	NA	75	NA	NA	NA	80	21	
Flexural modulus	MPa	—	—	—	1,800	1,400	1,400	—	—	—
Flexural strength	MPa	—	—	—	55	25	25	—	—	—
Tensile strength	MPa	2.5	6.2	3.3	—	—	—	3.0	1.1	—
Elongation at break	%	65	120	60	NA	NA	NA	30	220	—
Light transmissivity	400 nm/2 mm %	89	90	90	88	88	28	90	76	—
Softening point	°C	20	20	10	75	40	40	NA	NA	—
Coefficient of linear expansion	ppm									
	α1	80	65	70	72	70	70	—	—	—
	α2	250	410	280	190	220	220	250	480	400
Volume resistivity	TΩ·m	—	—	—	300	160	160	580	400	3.0
Dielectric breakdown strength	kV/mm	—	—	—	30.6	32.4	32.4	24.0	25.0	20.0
Relative permittivity	50 Hz	—	—	—	2.6	2.8	2.8	3.2	2.9	3.0
Dielectric dissipation factor	50 Hz	—	—	—	3 × 10 <sup>-3</sup>	2 × 10 <sup>-3</sup>	2 × 10 <sup>-3</sup>	5 × 10 <sup>-3</sup>	4.9 × 10 <sup>-4</sup>	5 × 10 <sup>-4</sup>
Adhesion strength	MPa									
	PPA	1.1	2.5	1.7	5.5 (Adherend failure)	5.6 (Adherend failure)	5.6 (Adherend failure)	0.8	0.3	—
	Silver	1.3	3.8	1.9	5.1	10.0	10.0	0.9	0.3	—
Moisture absorption	85°C/85%RH/24 h %	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	—
Water absorption	40°C/24 h %	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	< 0.1	—
Oxygen permeability	cc/m <sup>2</sup> ·day	320 (0.88 mm)	190 (0.94 mm)	450 (0.94 mm)	250 (0.92 mm)	150 (0.92 mm)	150 (0.92 mm)	17,000 (0.92 mm)	—	—

\* Measured at 25°C

(Not specified values)



## ■ Device die-bonding adhesives, damming materials & reflector materials

Cure system	One-component, addition									
Product name	KER-3000-M2	KER-3200-T7	X-32-2551	SMP-2840	KER-6020-F2	KER-3500-P2	KER-2000DAM	KER-2020-DAM	KCR-H2800	
Brief description	Transparent	Thermal interface material	Transparent	Electrically conductive	For sensor	For sensor	Dams for high density mounting	Dams for high density mounting, highly thixotropic	Heat resistant	
Category	Die-bond adhesive						Damming material		Reflector material	
	Methyl resin	Methyl resin	Methyl resin	Polyimide silicone	Phenyl rubber	Phenyl rubber	Methyl rubber	Methyl rubber	Organically modified silicone	
Before curing										
Appearance	Creamy white translucent	White	Creamy white transparent	Gray	Creamy white translucent	Gray	White	White	White	
Viscosity at 23°C	Pa·s	40	50	18	30	100	50	Non-fluid	Non-fluid	38
Solvent	Solventless	Isoparaffin	Solventless	Polyethylene glycol dimethyl ether	Solventless	Solventless	Solventless	Solventless	Solventless	
Non-volatile content	wt%	99	95	99	86	99	97	—	—	< 99
Standard curing conditions	100°C × 1 h + 150°C × 2 h			100°C × 2 h + 150°C × 1 h	150°C × 1 h	150°C × 30 min	120°C × 1 h		150°C × 4 h	
After curing										
Density at 23°C	g/cm <sup>3</sup>	1.15	2.45	1.13	5.6*2	1.09	1.73	1.10	1.20	1.94
Hardness	Shore D	56	80	55	6.0 GPa (Modulus of elasticity)	—	—	NA	NA	76
	Durometer A	NA	NA	NA		31	60	56	61	NA
Flexural modulus	MPa	270	350	260	—	—	—	—	—	—
Tensile strength	MPa	—	—	—	—	1.7	5.0	6.1	5.7	—
Elongation at break	%	—	—	—	—	200	90	140	120	—
Reflectance 450 nm/2 mm	%	—	—	—	—	—	—	95	99	99
Coefficient of linear expansion	ppm	α1	—	—	—	40*3	—	—	—	—
	α2		220	140	230	160*3	360	170	—	—
Thermal conductivity	W/m·K	0.20	1.00	0.20	1.00	—	0.48	—	—	—
Thermal resistance	mm <sup>2</sup> /K/W	15 (4 μm)	9 (9 μm)	—	8 (7 μm)	—	—	—	—	—
Volume resistivity	TΩ·m	100	20	100	NA	35.5	4.3	—	—	—
Dielectric breakdown strength	kV/mm	25	25	26	NA	26	26	—	—	—
Tensile lap-shear strength (Al/Al)	MPa	3.9	3.6	4.2	NA	1.0	1.2	1.1	1.0	7.6
Die shear strength*1		2,100	2,000	2,100	2,200	560*4	720*4	NA	NA	—
Process suited for:		Stamping/dispensing	Stamping/dispensing	Stamping/dispensing	Stamping	Dispensing	Dispensing	Dispensing/screen printing	Dispensing/screen printing	Compression/injection/transfer

\*1 Si chip (1 mm square, 0.35 mm thick) bonded to silver plating, curing conditions: 100°C × 1 h + 150°C × 2 h

(Not specified values)

\*2 Density before cured: 3.4 g/cm<sup>3</sup>

\*3 Glass transition point: around 185°C

\*4 Si chip (1 mm square, 0.27 mm thick) bonded to silver plating, curing conditions: 150°C × 2 h

UV curable products

Cure system	UV+condensation			UV + addition			UV radical			
Product name	KE-4835	KE-3431	KE-3432	KER-4530	KER-4531	KER-4410	KER-4130M-UV	KER-4130H-UV	KER-4700-UV	SMP-7004-3S
Brief description	Low viscosity	Med. viscosity	Low viscosity	UV + room temperature cure, low hardness	UV + room temperature cure, low hardness	Resin adhesion	Compatible with UV-LEDs, filling material	Compatible with UV-LEDs, damming material	High strength, high refractive index	Polyimide silicone
By-product gas	Alcohol	Acetone	Acetone	NA	NA	NA	NA	NA	NA	NA
Before curing										
Appearance	Creamy white translucent	Creamy white translucent	Creamy white translucent	Colorless transparent	Colorless transparent	Colorless slightly cloudy	Colorless transparent	Colorless transparent	Pale yellow transparent	Yellow transparent
Viscosity at 23°C Pa·s	6.0	30	10	4.0	25	59	2.9	16.2	0.05	2.0
Refractive index 23°C/589 nm	—	—	—	1.41	1.41	NA	1.45	1.45	1.51	1.48
UV irradiation conditions mJ/cm <sup>2</sup>	2,000*1	2,000*1	2,000*1	3,000*2	3,000*2	3,000*2	12,000*1	12,000*1	1,000*1	1,980*1
Standard curing conditions after UV irradiation	23°C / 50% RH × 3 days	23 ± 2°C / 50 ± 5% RH × 7 days		23°C × 2 h	23°C × 2 h	80°C × 1 h	NA	NA	NA	NA
After curing										
Density at 23°C g/cm <sup>3</sup>	1.01	1.08	1.06	0.97	0.97	1.06	1.04	1.06	1.10	1.00
Hardness	Shore D	NA	NA	NA	NA	NA	NA	NA	70	NA
	Durometer A	27	54	52	NA	NA	18	17	29	92
	Shore 00	NA	NA	NA	55	30 (Penetration*3)	NA	—	—	NA
Tensile strength MPa	1.1	2.7	2.6	0.3	NA	2.3	0.3	0.4	18.6	18.2
Elongation at break %	105	80	75	550	NA	350	140	100	9	120
Tensile lap-shear strength (glass) MPa	0.3	1.7	1.4	—	—	1.6 (Al/Al) 1.7 (PBT/PBT) 1.4 (PPS/PPS)	0.1	0.3	7.9	—
Young's modulus MPa	—	—	—	—	—	—	0.52	0.87	—	—
Cross adhesion strength (glass/glass)*4 MPa	—	—	—	0.5 (Film thickness 230 μm)	0.3 (Film thickness 230 μm)	—	0.8 (Film thickness 80 μm)	0.9 (Film thickness 80 μm)	—	—
Die shear strength*5 (glass/glass) MPa	—	—	—	—	—	—	—	—	—	10.7
Light transmittance*6 Thickness 2 mm	—	—	—	> 90	> 90	—	> 90	> 90	2	—

\*1 UV irradiation device: Metal halide lamp

\*2 UV irradiation device: 365nm UV-LED

\*3 Penetration: 1/4 cone

\*4 Please refer to the below diagram for measurement method.

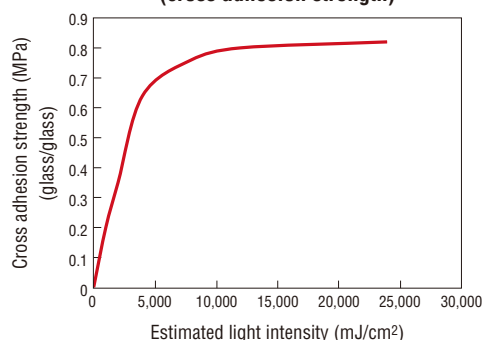
\*5 Room temperature, air atmosphere, metal halide lamp (33 mW) Estimated light intensity (2,000 mJ/cm<sup>2</sup>)

\*6 A 2 mm thick layer of material is applied to one side of a piece of glass.

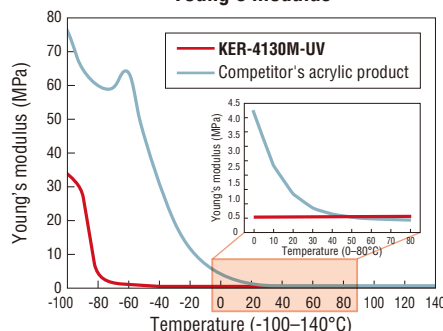
Light is shined at the opposite side and transmittance is measured and compared against the reference value, which is the transmittance of plain glass.

(Not specified values)

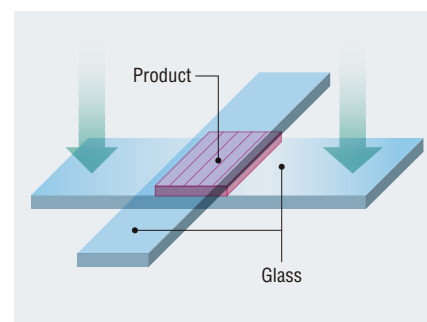
UV curing characteristics of KER-4130M-UV (cross adhesion strength)



Temperature dependence of Young's modulus



Measurement method of cross adhesion strength



Test method:

Two sheets of glass are stuck together in a cross shape, then the force required to pull them apart is measured.

Adhesion area: 500 mm<sup>2</sup> (25 mm × 20 mm)

Application thickness: 80 μm

Pulling speed: 5 mm/min

# Packaging options / Product index

Product name	Packaging	RoHS*2	Page
<b>G-1000</b>	200 g (tube) / 900 g (cartridge)	○	P20
<b>FE-2000</b>	120 g (tube) / 330 mL (cartridge)	○	P13
<b>KE-3412</b>	330 mL (cartridge) / 18 kg (pail can)	○	P12
<b>KE-3424-G</b>	120 g (tube) / 330 mL (cartridge)	○	P19
<b>KE-3446-W</b>	330 mL (cartridge)	○	P13
<b>KE-3449-W</b>	100 g (tube)	○	P13
<b>KE-3456</b>	1 kg (square can) / 17 kg (pail can)	○	P19
<b>KE-3467</b>	250 g (tube) / 330 mL (cartridge)	○	P20
<b>KE-3476-T</b>	16 kg (pail can)	○	P19
<b>KE-3490</b>	100 g, 110 g, 200 g (tube), 330 mL (cartridge)	○	P12
<b>KE-3491</b>	100 g (tube) / 330 mL (cartridge)	○	P13
<b>KE-3492</b>	50 g, 160 g (tube) / 330 mL (cartridge)	○	P13
<b>KE-3494</b>	100 g, 110 g (tube) / 330 mL (cartridge)	○	P12
<b>KE-3495</b>	100 g (tube) / 330 mL (cartridge)	○	P19
<b>KE-4806-W</b>	100 g (tube) / 330 mL (cartridge)	○	P13
<b>KE-4901-W</b>	330 mL (cartridge)	○	P12
<b>KE-4908-T</b>	330 mL (cartridge)	○	P12
<b>KE-4914-G</b>	330 mL (cartridge)	○	P18
<b>KE-4916-B</b>	330 mL (cartridge) / 20 kg (pail can)	○	P12
<b>KE-4917-B</b>	330 mL (cartridge)	○	P12
<b>KE-4918-WF</b>	150 g (tube) / 330 mL (cartridge), 20 kg (pail can)	○	P13
<b>KE-4918-WHITE</b>	330 mL (cartridge) / 20 kg (pail can)	○	P13
<b>KE-4920-B</b>	330 mL (cartridge)	○	P18
<b>KE-4920-T</b>	90 g (tube) / 330 mL (cartridge), 1 kg (square can)	○	P18
<b>KE-4920-W</b>	330 mL (cartridge) / 1 kg (square can)	○	P18
<b>KE-4921-W</b>	330 mL (cartridge)	○	P18
<b>KE-4930-G</b>	330 mL (cartridge) / 20 kg (pail can)	○	P12
<b>KE-4948-G</b>	330 mL (cartridge)	○	P13
<b>KE-4956-T</b>	330 mL (cartridge)	○	P12
<b>KE-4961-W</b>	230 g (tube) / 330 mL (cartridge)	○	P20
<b>KE-4962-W</b>	330 mL (cartridge)	○	P20
<b>KE-4967-W</b>	330 mL (cartridge)	○	P20

Product name	Packaging	RoHS*2	Page
<b>KE-4970</b>	1 kg (square can) / 18 kg (pail can)	○	P18
<b>KE-4971</b>	1 kg (square can) / 18 kg (pail can)	○	P18
<b>KST-647</b>	900 g, 15 kg (square can)	○	P18
<b>KE-200</b>	1 kg (plastic container) / 18 kg (pail can)	○	P16
<b>IO-SEAL-300</b>	1 kg (round can) / 20 kg (pail can)	○	P15
<b>FE-61</b>	130 g (tube) / 1 kg (round can)	○	P15
<b>FE-73</b>	100 g, 1 kg (plastic bottle)	○	P17
<b>G-789</b>	1 kg (cartridge)	○	P20
<b>KE-1056</b>	1 kg (plastic bottle) / 15 kg (square can)	○	P17
<b>KE-1057</b>	1 kg, 16 kg (square can)	○	P17
<b>KE-1061</b>	1 kg, 16 kg (square can)	○	P17
<b>KE-1062</b>	1 kg, 16 kg (square can)	○	P17
<b>KE-1812</b>	340 g (cartridge)	○	P15
<b>KE-1831</b>	100 g (tube) / 1 kg (round can) / 20 kg (pail can)	○	P14
<b>KE-1833</b>	420 g (cartridge) / 1 kg (round can) / 20 kg (pail can)	○	P14
<b>KE-1835-S</b>	410 g (cartridge) / 1 kg (round can) / 20 kg (pail can)	○	P14
<b>KE-1844</b>	1 kg (square can) / 16 kg (pail can)	○	P19
<b>KE-1846</b>	1 kg (round can) / 18 kg (pail can)	○	P19
<b>KE-1849</b>	4 kg (plastic container) 1 kg (plastic bottle) / 18 kg (plastic straight can)	○	P15
<b>KE-1850</b>	400 g (cartridge) / 18 kg (pail can)	○	P14
<b>KE-1854</b>	1 kg (round can) / 18 kg (pail can)	○	P14
<b>KE-1855</b>	1 kg (round can) / 18 kg (pail can)	○	P14
<b>KE-1867</b>	200 g (glass bottle) / 900 g (cartridge) 1 kg, 2 kg (round can) / 20 kg (pail can)	○	P20
<b>KE-1869</b>	1 kg, 5.5 kg (round can)	○	P20
<b>KE-1871</b>	1 kg (round can) / 15 kg (pail can)	○	P19
<b>KE-1875</b>	350 g (cartridge) / 18 kg (plastic straight can)	○	P14
<b>KE-1880</b>	370 g (cartridge) / 1 kg (round can) / 16 kg (pail can)	○	P14
<b>KE-1884</b>	100 g (tube) / 1 kg (round can) / 20 kg (pail can)	○	P15
<b>KE-1885</b>	100 g (tube) / 1 kg (round can) / 20 kg (pail can)	○	P15
<b>KE-1886</b>	100 g (tube) / 340 g (cartridge) 1 kg (round can) / 20 kg (pail can)	○	P19
<b>KE-1891</b>	300 g (glass bottle) / 1 kg, 3 kg (round can) 20 kg (pail can)	○	P20
<b>KCR-H2800</b>	250 g (syringe)	○	P24

Product name	Packaging	RoHS*2	Page
<b>KER-2000DAM</b>	30 g, 50 g (syringe)	○	P24
<b>KER-2020-DAM</b>	30 g, 50 g (syringe)	○	P24
<b>KER-3000-M2</b>	6 g, 10 g, 25 g (syringe)	○	P24
<b>KER-3200-T7</b>	10 g (syringe)	○	P24
<b>KER-3500-P2</b>	5 g (syringe)	○	P24
<b>KE-6020-F</b>	30 g (syringe)	○	P23
<b>KER-6020-F2</b>	5 g, 10 g, 30 g (syringe)	○	P24
<b>KER-6075-F</b>	30 g (syringe) / 1 kg (plastic bottle)	○	P23
<b>KER-6230-F</b>	30 g (syringe)	○	P23
<b>SMP-2840</b>	10 g (plastic bottle)	○	P24
<b>X-32-2551</b>	6 g (syringe)	○	P24
<b>ASP-1120-A/B</b>	A:50 g, 100 g, 1 kg (plastic bottle) B:50 g, 100 g, 1 kg (plastic bottle)	○	P23
<b>ASP-2010-A/B</b>	A:20 g (glass bottle) / 100 g (plastic bottle) B:80 g (glass bottle) / 800 g (plastic bottle)	○	P23
<b>ASP-2020-A/B</b>	A:11 g (glass bottle) / 100 g (plastic bottle) B:90 g (glass bottle) / 900 g (plastic bottle)	○	P23
<b>FE-77-A/B</b>	A:100 g, 1 kg (plastic bottle) B:100 g, 1 kg (plastic bottle)	○	P17
<b>FER-7061-A/B</b>	A:20 g, 100 g (plastic bottle) B:80 g, 800 g (plastic bottle)	○	P22
<b>FER-7110-A/B</b>	A:20 g, 100 g (plastic bottle) B:80 g, 800 g (plastic bottle)	○	P22
<b>KE-1012-A/B</b>	A:1 kg (round can) / 16 kg (straight bottle) B:1 kg (round can) / 16 kg (square can)	○	P17
<b>KE-1013-A/B</b>	A:1 kg, 16 kg (square can) B:1 kg, 16 kg (square can)	○	P17
<b>KE-1051J-A/B</b>	A:1 kg (square can), 18 kg (pail can) B:1 kg (square can), 18 kg (pail can)	○	P17
<b>KE-1063-A/B</b>	A:1 kg, 16 kg (square can) B:1 kg, 16 kg (square can)	○	P17
<b>KE-106F</b>	900 g (round can) / 18 kg (pail can)	○	P16
<b>KE-109E-A/B</b>	A:1 kg (round can), 16 kg (square can) B:1 kg (round can), 16 kg (square can)	○	P16
<b>KE-1180-A/B*1</b>	A:1 kg (round can) / 18 kg (pail can) B:1 kg (round can) / 18 kg (pail can)	○	P15
<b>KE-1182-A/B*1</b>	A:1 kg (round can) / 18 kg (pail can) B:1 kg (round can) / 18 kg (pail can)	○	P15
<b>KE-1184-A/B</b>	A:1 kg (round can) / 20 kg (pail can) B:1 kg (round can) / 20 kg (pail can)	○	P21
<b>KE1204A/B</b>	A:1 kg (plastic container) / 25 kg (pail can) B:1 kg (plastic container) / 25 kg (pail can)	○	P16
<b>KE-1280-A/B</b>	A:1 kg (round can) / 18 kg (pail can) B:1 kg (round can) / 18 kg (pail can)	○	P16
<b>KE-1282-A/B</b>	A:1 kg (round can) / 20 kg (pail can) B:1 kg (round can) / 20 kg (pail can)	○	P16
<b>KE-1283-A/B</b>	A:1 kg (round can) / 9 kg, 18 kg (pail can) B:1 kg (round can) / 9 kg, 18 kg (pail can)	○	P16
<b>KE-1285-A/B</b>	A:1 kg (round can) / 20 kg (pail can) B:1 kg (round can) / 20 kg (pail can)	○	P16
<b>KE-1292-A/B</b>	A:1 kg (round can) / 20 kg (pail can) B:1 kg (round can) / 20 kg (pail can)	○	P16

Product name	Packaging	RoHS*2	Page
<b>KE-1897-A/B</b>	A:1 kg (round can) / 10 kg (pail can) B:1 kg (round can) / 10 kg (pail can)	○	P16, 21
<b>KE-1898-A/B</b>	A:1 kg (round can) / 10 kg (pail can) B:1 kg (round can) / 10 kg (pail can)	○	P21
<b>KE-1899-A/B</b>	A:1 kg (round can) / 20 kg (pail can) B:1 kg (round can) / 20 kg (pail can)	○	P21
<b>KER-2500-A/B</b>	A:100 g, 1 kg (plastic bottle) B:100 g, 1 kg (plastic bottle)	○	P22
<b>KER-2600-A/B</b>	A:100 g, 1 kg (plastic bottle) B:100 g, 1 kg (plastic bottle)	○	P22
<b>KER-2910-A/B</b>	A:50 g, 1 kg (plastic bottle) B:50 g, 1 kg (plastic bottle)	○	P22
<b>KER-2937-A/B</b>	A:100 g, 1 kg (plastic bottle) B:100 g, 1 kg (plastic bottle)	○	P22
<b>KER-2938-A/B</b>	A:100 g, 1 kg (plastic bottle) B:40 g, 100 g (plastic bottle)	○	P22
<b>KER-6150-A/B</b>	A:100 g, 1 kg (plastic bottle) B:100 g, 1 kg (plastic bottle)	○	P22
<b>KER-6200-A/B</b>	A:100 g, 1 kg (plastic bottle) B:100 g, 1 kg (plastic bottle)	○	P22
<b>SCR-1012A/B-R</b>	A:100 g, 1 kg (plastic bottle) B:100 g, 1 kg (plastic bottle)	○	P23
<b>SCR-1016A/B</b>	A:100 g, 1 kg (plastic bottle) B:100 g, 1 kg (plastic bottle)	○	P23
<b>SCR-1018A (S2)/B</b>	A:100 g, 1 kg (plastic bottle) B:100 g, 1 kg (plastic bottle)	○	P23
<b>SDP-1030-A/B*1</b>	A:800 g (cartridge) / 1 kg (round can) / 20 kg (pail can) B:800 g (cartridge) / 1 kg (round can) / 20 kg (pail can)	○	P21
<b>SDP-2060-A/B*1</b>	A:900 g (cartridge) / 1 kg (round can) / 20 kg (pail can) B:900 g (cartridge) / 1 kg (round can) / 20 kg (pail can)	○	P21
<b>SDP-3540-A/B*1</b>	A:900 g (cartridge) / 1 kg (round can) / 20 kg (pail can) B:900 g (cartridge) / 1 kg (round can) / 20 kg (pail can)	○	P21
<b>SDP-5040-A/B*1</b>	A:900 g (cartridge) / 1 kg (round can) / 20 kg (pail can) B:900 g (cartridge) / 1 kg (round can) / 20 kg (pail can)	○	P21
<b>SDP-6560-A/B</b>	A:500 g (round can) / 900 g (cartridge) / 1 kg (round can) B:500 g (round can) / 900 g (cartridge) / 1 kg (round can)	○	P21
<b>GUV-300</b>	500 g (round can) / 900 g (cartridge) / 1 kg (round can)	○	P21
<b>KE-3431</b>	330 mL (cartridge)	○	P25
<b>KE-3432</b>	100 g (tube)	○	P25
<b>KE-4835</b>	330 mL (cartridge)	○	P25
<b>KER-4130H-UV</b>	40 g (syringe)	○	P25
<b>KER-4130M-UV</b>	30 g (syringe) / 100 g (glass bottle) / 1 kg (round can)	○	P25
<b>KER-4410</b>	30 g (syringe) / 1 kg (round can)	○	P25
<b>KER-4530</b>	30 cc, 50 cc (syringe) / 100 g (dark brown bottle) 1 kg (round can)	○	P25
<b>KER-4531</b>	30 cc, 50 cc (syringe) / 100 g (dark brown bottle) 1 kg (round can)	○	P25
<b>KER-4700-UV</b>	100 g (glass bottle) / 1 kg (square can)	○	P25
<b>SMP-7004-3S</b>	5 g, 30 g (syringe) / 100 g, 250 g (plastic bottle)	○	P25

■ One-component, condensation	■ Two-component, condensation
■ One-component, addition	■ Two-component, addition
■ UV cure	

\*1 Double-barrel cartridges (50 mL) can be provided as samples for evaluation.

These double-barrel cartridges are not mass-produced, and are available for evaluation purposes only.

\*2 ○: This indicates that none of the six RoHS-prohibited substances

(Cd, Cr6+, Hg, Pb, PBB, PBED) are used intentionally as ingredients.

# Packaging

We offer a variety of packaging options, based on product characteristics and for optimal usability.



Some of the available packaging options



Syringes



Glass bottles



Tubes / cartridges



1 kg cans



Plastic bottles



Metal cans (pail cans / round cans / square cans)



# UL certified products

## QMFZ2. Component — Plastics

File No.	Company Name	Grade	Thickness mm	Flame Class	HWI	HAI	RTI			HVTR	D495	CTI
							Elec.	Imp.	Str.			
E48923	SHIN-ETSU CHEMICAL CO., LTD.	IO-SEAL-300	1.5	HB	—	—	150	150	150	—	—	—
		KE1204A/B	0.89	V-0	0	0	150	150	150	0	0	0
		KE-1280-A/B	3.0	V-0	—	—	150	150	150	—	—	—
		KE-1281-A/B*	0.8	V-1	—	—	150	150	150	—	—	—
		KE-1285-A/B	6.0	V-0	—	—	150	150	150	—	—	—
		KE-1292-A/B	0.75	V-0	—	—	150	150	150	—	—	—
		KE-1812	1.5	HB	—	—	150	150	150	—	—	—
		KE-1831	0.75	V-0	3	0	150	150	150	0	4	0
			3.0	V-0	2	0	150	150	150			
		KE-1835-S	2.0-2.2	HB	—	—	150	150	150	—	—	—
		KE-1861-A/B*	6.0	V-0	—	—	150	150	150	—	—	—
		KE-1862*	3.0	V-0	—	—	150	150	150	—	—	—
		KE-1867	0.8	V-0	—	—	150	150	150	—	—	—
		KE-1880	1.3	V-1	2	0	150	150	150	—	—	0
			2.4-2.6	V-0	1	0	150	150	150			
		KE-1891	2.0	V-0	—	—	150	150	150	—	—	—
		KE-1897-A/B	6.5	V-0	—	—	150	150	150	—	—	—
		KE-200/CX-200	1.5	HB	—	0	105	105	105	—	—	0
			3.0	HB	3	0	105	105	105			
			8.5	V-1	—	—	105	105	105			
		KE-200F* CX-200	1.5	HB	—	0	115	115	115	—	—	0
			8.5	V-1	—	—	115	115	115			
		KE-210F* CAT-210	3.0	V-0	1	0	105	105	105	—	—	0
			10.0	V-0	0	0	105	105	105			
		KE-225A/B*	1.1	HB	—	—	105	105	105	—	—	0
			3.0	V-0	0	0	105	105	105			
		KE-3424-G	2.0	V-1	—	—	105	105	105	—	—	—
		KE-3466*	0.8-0.9	V-1	—	—	105	105	105	—	—	—
		KE-3467	0.8	V-1	—	—	105	105	105	—	—	—
			2.0-2.2	V-0	—	—	105	105	105			
		KE-3490	0.75	V-1	1	0	105	105	105	0	5	1
			1.5	V-1	0	—	105	105	105			
			3.0	V-0	0	0	105	105	105			
		KE-3494	0.75	V-1	0	0	105	105	105	0	5	2
			1.5	V-0	0	—	105	105	105			
			3.0	V-0	0	0	105	105	105			
		KE-4901-G*	2.0	V-0	1	0	105	105	105	0	—	0
			3.0	V-0	0	0	105	105	105			
		KE-4901-W	2.0	V-0	—	—	105	105	105	—	—	—
		KE-4914-G	2.5	V-0	—	—	105	105	105	—	—	—
KE-4916-B	2.0	V-0	—	—	105	105	105	—	—	—		
KE-4917-B	1.5	V-0	—	—	105	105	105	—	—	—		
KE-4918-GRAY*	2.0	V-0	1	0	105	105	105	—	—	—		
KE-4918-WHITE	2.0	V-0	1	0	105	105	105	—	—	—		
KE-4918-GF*	2.0	V-0	—	—	105	105	105	—	—	—		
KE-4918-WF	2.0	V-0	—	—	105	105	105	—	—	—		
KE-4948-G	5.4	V-0	—	—	105	105	105	—	—	—		
KE-4961-W	3.0	V-0	—	—	105	105	105	—	—	—		
KER-2500-A/B	0.5	HB	—	—	150	150	150	—	—	—		
KER-6020-F	0.4	HB	—	—	150	150	150	—	—	—		
E174951	SHIN-ETSU SILICONE TAIWAN CO., LTD.	KE-1283 A/B/C	6.0-6.6	V-1	—	—	105	105	105	—	—	—

## QMJU2. Component — Coatings for use on Printed Wiring Boards

File No.	Company Name	Grade	Coating Material			Elec Temp °C	Env Cond	Laminate		
			Min Thk mic	Max Thk mic	Flame Class			Min Space	ANSI Type	Min Thk mm
E181060	SHIN-ETSU SILICONES OF AMERICA, INC.	KE-4970	255	323	V-0	130	indoor/outdoor	0.74	FR-4,CEM-1,CEM-3	1.5
		KE-4971	246	457	V-0	130	indoor/outdoor	0.78	FR-4,CEM-1,CEM-3	1.5

\* Product not featured in this catalog.

\* Not all of Shin-Etsu's UL certified products are shown in the list above. For information on UL certification, go to <http://iq.ul.com/>. Check the UL file numbers below for details.

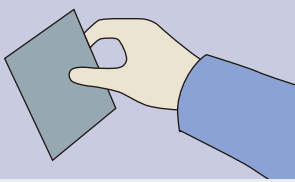
Plastics: **E48923, E179895, E174951, E255646, E192980** Coatings for use on Printed Wiring Boards: **E181060**



# Instructions for use

## Usage instructions for one-component RTV silicone rubbers

**Clean the application surface**




Clean the surface of all rust, oil, dirt, grime and other substances that may interfere with adhesion using sandpaper or a solvent (toluene, xylene, other). When cleaning plastics with solvents, use caution as some solvents may damage plastics.

**To save for later use**

**Tubes**  
Remove the nozzle and seal tightly. Clean residue out of the nozzle using a solvent.


**Cartridges**  
Product should be used all at once if possible. If product remains, seal tightly before storage. If tightly sealed, the product can be kept for several days.

**Tubes**



Open the tube and load it into the dispenser cartridge .

**Cartridges**



Cut the nozzle tip and load the cartridge into the dispenser cartridge.

**Application can be done by machine or by hand**






Photo provided by Musashi Engineering Inc.

## Usage instructions for two-component RTV silicone rubbers

**Before use**


Check the mix ratio carefully when using two-component RTV silicone rubber products. All ratios are given in parts by weight. Put the base polymer (A) into a container, followed by the curing agent (B). Mix thoroughly until evenly mixed throughout.

Be sure to deaerate the product after mixing. When using a planetary-centrifugal type mixer/deaerator, friction within the product can cause a sharp rise in temperature. Also be aware that with certain low viscosity products, there may be some settling of the fillers during storage. Before use, first agitate well to disperse the fillers and then proceed to mixing the two components.


**To store**

Be sure to seal the product tightly before storage. Use a solvent or other cleaning agent to clean stirrers, containers and other tools used in the mixing process after use.

**Stir before use**




**Use**




After mixing and deaeration, immediately pour into place.

**Weigh**




Weigh out both the base polymer and curing agent.

**Combine**




**Mix**



Combine the base polymer and curing agent, and mix until color is uniform and consistent.

**Deaerate**



# Handling precautions

## Handling precautions

1. One-component condensation-cure RTV silicone rubbers cure by reacting with moisture in the air, and curing starts at the surface. Curing speed is affected by temperature, humidity and other conditions. These products do not have particularly good deep-section cure properties, and are thus not suitable for adhesive applications in which the contact area is large. Additionally, if the product is used when humidity is above 100% and water droplets form on the rubber during the cure process, a hydrolysis reaction will proceed ahead of the crosslinking curing reaction, in which case the rubber may have reduced strength or exhibit surface tack after curing.
2. Although they are not featured in this catalog, certain one-component condensation-cure RTV silicone rubber products (including acetic acid-release and oxime-release types) may cause metal corrosion. Acetic acid-release types can cause rust, while oxime-release types can cause corrosion of copper-based metals in airtight conditions. The user should thus conduct a preliminary test with a sample to determine whether the product is suited to the intended application.
3. Condensation-cure RTV silicone rubbers will show a temporary decline in dielectric properties during the cure process. In most cases, however, the rubber will recover and exhibit its intrinsic dielectric properties when fully cured.
4. If product gets on the floor, it will become slippery. Wipe the product to remove completely.
5. Condensation-cure RTV silicone rubber products should not be used in places where completely airtight conditions will be created.
6. Condensation-cure RTV silicone rubbers may yellow over time, but their other characteristics will not be affected.
7. Addition-cure RTV silicone rubber products may not cure properly if they are contaminated with or come in contact with certain cure-inhibiting substances (e.g. sulfur, phosphorus, nitrogen compounds, water, organometallic salts). See "Cure inhibitors" on p.8.
8. Addition-cure RTV silicone rubber products should not be used in high humidity conditions, as this can result in curing problems or poor adhesion.
9. Be aware that addition-cure RTV silicone rubber products release tiny amounts of hydrogen gas as they cure.

## Precautions when using

1. Please contact your sales representative if you have any questions regarding the handling and use of these products.
2. Be sure to clean the substrate to remove dirt, grime, moisture and oil from the surface.
3. When using two-component products, be sure to measure, mix, stir and deaerate thoroughly. If these steps are not done properly, it may adversely affect the properties of the rubber.
4. When using an air gun applicator, be sure to set the pressure at a safe and suitable level, around 0.2–0.3 MPa MAX.
5. The products in the KE-200 series cure quickly at room temperature. When using these products, use of a special dispenser is recommended.
6. The curing agents for KE-200 and KE-210 undergo hydrolysis when exposed to moisture, meaning it is best to use the entire contents of the container soon after opening. Moreover, if the dispenser tank is being pressurized with air, be sure to use a dry air supply.

## Safety and hygiene

1. Be sure there is adequate ventilation when using condensation-cure RTV silicone rubber products. As condensation-cure RTV silicone rubber products cure, acetic acid-cure products release acetic acid; alcohol-cure products release methanol; oxime-cure products release methyl ethyl ketoxime (MEKO); and acetone-cure products release acetone. If you experience unpleasant symptoms when using these products, move to an area with fresh air.
2. Uncured RTV silicone rubber products may irritate skin and mucous membranes. Take care to avoid eye contact or prolonged contact with the skin. In case of accidental eye contact, immediately flush with water for at least 15 minutes and then seek medical attention. In case of skin contact, wipe off immediately with a dry cloth and then wash thoroughly with soap and water. Contact lens wearers must take special care when using RTV silicone rubber: if uncured RTV silicone rubber enters the eye, the contact lens may become stuck to the eye.
3. Never touch or rub the eyes while working with these products. Users should wear safety glasses and take other appropriate steps to protect their safety.
4. If product gets on the floor, it will become slippery. Wipe the product to remove completely.
5. These RTV silicone rubber products are classified as Class 4 Hazardous Materials or Designated Combustibles (combustible solids and synthetic resins) under the Fire Service Act of Japan. In your country, other laws may apply. Be sure that storage of these products is done in accordance with local laws with regard to labeling and other issues.
6. Keep out of reach of children.
7. Be sure to read the Safety Data Sheets (SDS) for these products before use. SDS are available from the Shin-Etsu Sales Department.

## Precautions related to storage

1. Store at room temperature (1–30°C), out of direct sunlight. Note that certain products must be kept at 1°–25°C. If the product label says "keep refrigerated", it should be kept at temperatures of 10°C or below. Note that KER-4410, KER-4530, KER-4531 must be kept at between 0°C and 10°C. KER-3000-M2, KER-3200-T7, X-32-2551, KER-2000DAM, KER-2020-DAM and KCR-H2800 must be kept at between -10°C and 10°C. SMP-2840 must be kept at between -40°C and -20°C.
2. Once products have been opened, the entire contents should be used at one time whenever possible. If some remains, be sure to seal the container completely.
3. After prolonged storage of products with low viscosity and high specific gravity, oil may have separated, but it does not mean there is a problem with product. Stir the product well before using.

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**Gunma Complex** ISO 9001 ISO 14001  
(JCQA-0004 JCQA-E-0002)

**Naoetsu Plant** ISO 9001 ISO 14001  
(JCQA-0018 JCQA-E-0064)

**Takefu Plant** ISO 9001 ISO 14001  
(JQA-0479 JQA-EM0298)